DATA SHEET

ReWritable
CD
COMPATIBLE

I²C
BUS

SAA7324
Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

Philips
Semiconductors

PHILIPS

PHILIPS

CONTENTS

Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

SAA7324

1 FEATURES

- Integrated bitstream DAC with differential outputs, operating at $96f_s$ with 3rd-order noise shaper; typical performance of -90 dB signal-to-noise ratio

- Separate serial input and output interfaces allow data 'loopback' mode for use of onboard DAC with external Electronic Shock Absorption (ESA) systems

- Up to 4 times speed mode

- Low voltage operation at up to 2 times speed

- Lock-to-disc mode

- Full error correction strategy, $t = 2$ and $e = 4$

- Full CD graphics interface

- All standard decoder functions implemented digitally on chip

- FIFO overflow concealment for rotational shock resistance

- Digital audio interface (EBU), audio and data

- Two and four times oversampling integrated digital filter, including f_s mode

- Audio data peak level detection

- Kill interface for external DAC deactivation during digital silence

- All SAA737x (CD7) digital servo and high-level functions

- Low focus noise

- Same playability performance as SAA737x (CD7)

- Automatic closed-loop gain control available for focus and radial loops

- Pulsed sledge support

- Electronic damping of fast radial actuator during long jump

- Microcontroller loading LOW

- High-level servo control option

- High-level mechanism monitor

- Communication may be via TDA1301/SAA7345 compatible bus or I²C-bus

- On-chip clock multiplier allows the use of 8.4672, 16.9344 or 33.8688 MHz crystals or ceramic resonators.

2 GENERAL DESCRIPTION

The SAA7324 (CD10 II) is a single chip combining the functions of a CD decoder, digital servo and bitstream DAC. The decoder/servo part is based on the SAA737x (CD7) and is software compatible with this design. Extra functions are controlled by use of 'shadow' registers (see Section 7.15.3).

Supply of this Compact Disc IC does not convey an implied license under any patent right to use this IC in any Compact Disc application.

3 ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
SAA7324H	QFP64	plastic quad flat package; 64 leads (lead length 1.6 mm); body 14 × 14 × 2.7 mm	SOT393-1

4 QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{DD}	supply voltage	n = 4 mode; note 1	3.0	3.3	3.6	V
		n = 1 or 2 mode; note 1	2.4	–	3.6	V
I_{DD}	supply current	V_{DD} = 3.3 V	–	20	–	mA
		V_{DD} = 2.4 V	–	14	–	mA
f_{xtal}	crystal frequency		4	8.4672	35	MHz
T_{amb}	ambient temperature		–10	–	+70	°C
T_{stg}	storage temperature		–55	–	+125	°C
S/N_{DAC}	onboard DAC signal-to-noise ratio	1 kHz; $1f_s$; see Figs 38 and 39	–85	–90	–	dB

Note

1. n = overspeed factor.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)   SAA7324

5 BLOCK DIAGRAM

Fig.1 Block diagram.
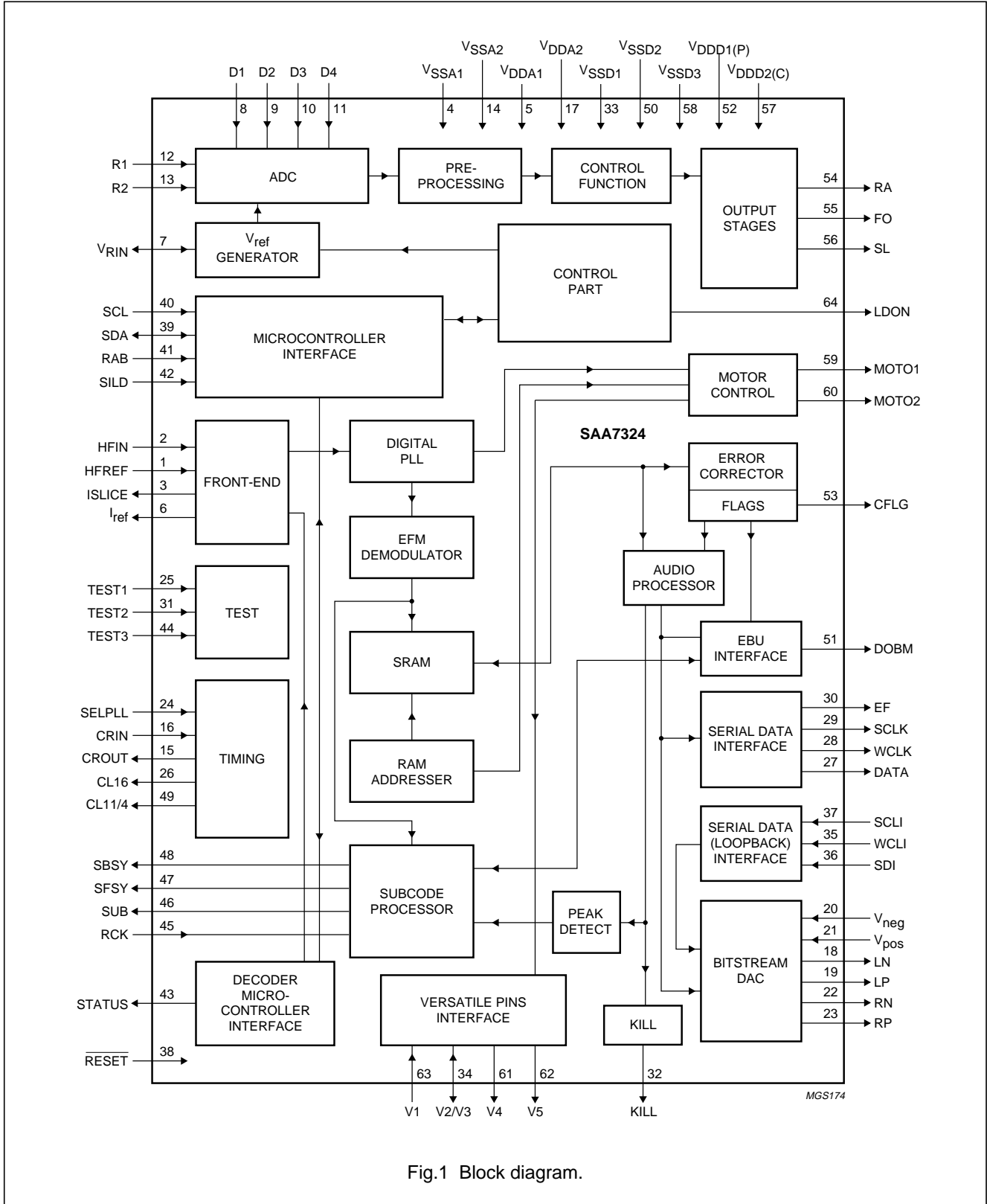
Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

SAA7324

6 PINNING

SYMBOL	PIN	DESCRIPTION
HFREF	1	comparator common mode input
HFIN	2	comparator signal input
ISLICE	3	current feedback output from data slicer
V_{SSA1}	4[1]	analog ground 1
V_{DDA1}	5[1]	analog supply voltage 1
I_{ref}	6	reference current output
V_{RIN}	7	reference voltage for servo ADCs
D1	8	unipolar current input 1 (central diode signal input)
D2	9	unipolar current input 2 (central diode signal input)
D3	10	unipolar current input 3 (central diode signal input)
D4	11	unipolar current input 4 (central diode signal input)
R1	12	unipolar current input 1 (satellite diode signal input)
R2	13	unipolar current input 2 (satellite diode signal input)
V_{SSA2}	14[1]	analog ground 2
CROUT	15	crystal/resonator output
CRIN	16	crystal/resonator input
V_{DDA2}	17[1]	analog supply voltage 2
LN	18	DAC left channel differential negative output
LP	19	DAC left channel differential positive output
V_{neg}	20	DAC negative reference input
V_{pos}	21	DAC positive reference input
RN	22	DAC right channel differential negative output
RP	23	DAC right channel differential positive output
SELPLL	24	selects whether internal clock multiplier PLL is used
TEST1	25	test control input 1 (this pin should be tied LOW)
CL16	26	16.9344 MHz system clock output
DATA	27	serial d4(1) data output (3-state)
WCLK	28	word clock output (3-state)
SCLK	29	serial bit clock output (3-state)
EF	30	C2 error flag output (3-state)
TEST2	31	test control input 2 (this pin should be tied LOW)
KILL	32	kill output (programmable; open-drain)
V_{SSD1}	33[1]	digital ground 1
V2/V3	34	versatile I/O: versatile input 2 or versatile output 3 (open-drain)
WCLI	35	word clock input (for data loopback to DAC)
SDI	36	serial data input (for data loopback to DAC)
SCLI	37	serial bit clock input (for data loopback to DAC)
$\overline{RESET}$	38	power-on reset input (active LOW)
SDA	39	microcontroller interface data I/O line (I^2C-bus; open-drain output)
SCL	40	microcontroller interface clock line input (I^2C-bus)

Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

SAA7324

SYMBOL	PIN	DESCRIPTION
RAB	41	microcontroller interface R/$\overline{\text{W}}$ and load control line input (4-wire bus mode)
SILD	42	microcontroller interface $\overline{\text{R}}$/W and load control line input (4-wire bus mode)
STATUS	43	servo interrupt request line/decoder status register output (open-drain)
TEST3	44	test control input 3 (this pin should be tied LOW)
RCK	45	subcode clock input
SUB	46	P-to-W subcode bit 3-states output (3-state)
SFSY	47	subcode frame sync output (3-state)
SBSY	48	subcode block sync output (3-state)
CL11/4	49	11.2896 or 4.2336 MHz (for microcontroller) clock output
V_{SSD2}	50[1]	digital ground 2
DOBM	51	bi-phase mark output (externally buffered; 3-state)
$V_{DDD1(P)}$	52[1]	digital supply voltage 1 for periphery
CFLG	53	correction flag output (open-drain)
RA	54	radial actuator output
FO	55	focus actuator output
SL	56	sledge control output
$V_{DDD2(C)}$	57[1]	digital supply voltage 2 for core
V_{SSD3}	58[1]	digital ground 3
MOTO1	59	motor output 1; versatile (3-state)
MOTO2	60	motor output 2; versatile (3-state)
V4	61	versatile output 4
V5	62	versatile output 5
V1	63	versatile input 1
LDON	64	laser drive on output (open-drain)

Note

1. All supply pins must be connected to the same external power supply voltage.
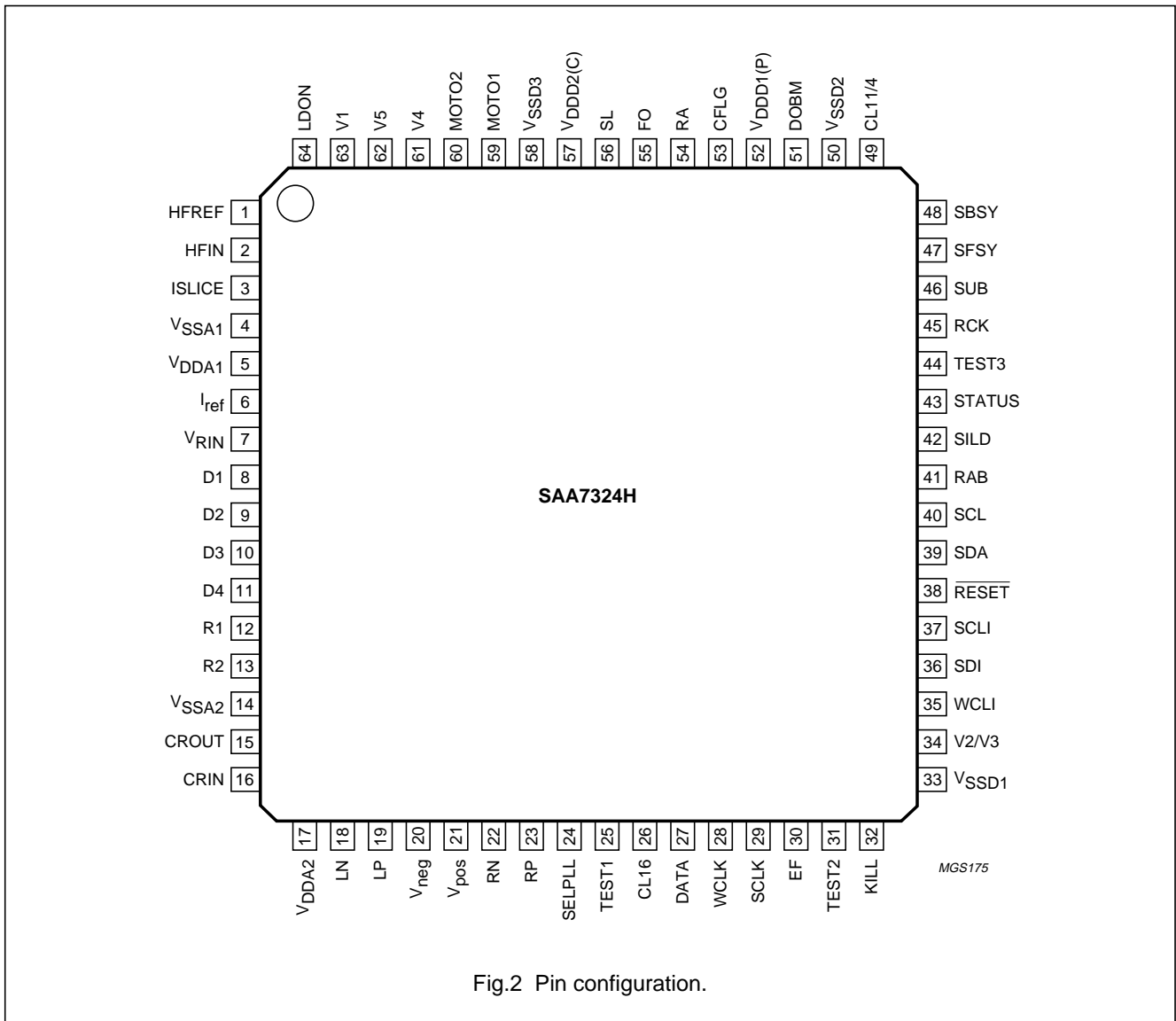
Fig.2 Pin configuration.

7 FUNCTIONAL DESCRIPTION

7.1 Decoder part

7.1.1 PRINCIPAL OPERATING MODES OF THE DECODER

The decoding part supports a full audio specification and can operate at two different disc speeds, from single-speed ($n = 1$) to 4 times speed ($n = 4$). The factor 'n' is called the overspeed factor. A simplified data flow through the decoder part is illustrated in Fig.7.

7.1.2 DECODING SPEED AND CRYSTAL FREQUENCY

The SAA7324 is a two speed decoding device, with an internal Phase-Locked Loop (PLL) clock multiplier. Depending on the crystal frequency used and the internal clock settings (selectable via decoder register B), the playback speeds shown in Table 1 are possible, where 'n' is the overspeed factor (1, 2 or 4).

An internal clock multiplier is present, controlled by SELPLL, and should only be used if a 8.4672 or 16.9344 MHz crystal, ceramic resonator or external clock is present.

7.1.3 LOCK-TO-DISC MODE

For electronic shock absorption applications, the SAA7324 can be put into lock-to-disc mode. This allows Constant Angular Velocity (CAV) disc playback with varying input data rates from the inside-to-outside of the disc.

In the lock-to-disc mode, the FIFO is blocked and the decoder will adjust its output data rate to the disc speed. Hence, the frequency of the I²S-bus (WCLK and SCLK) clocks are dependent on the disc speed. In the lock-to-disc mode there is a limit on the maximum variation in disc speed that the SAA7324 will follow. Disc speeds must always be within 25% to 100% range of their nominal value. The lock-to-disc mode is enabled/disabled by decoder register E.

7.1.4 STANDBY MODES

The SAA7324 may be placed in two standby modes selected by decoder register B (it should be noted that the device core is still active):

- Standby 1: CD-STOP mode; most I/O functions are switched off

- Standby 2: CD-PAUSE mode; audio output features are switched off, but the motor loop, the motor output and the subcode interfaces remain active; this is also called a 'Hot Pause'.

In the standby modes the various pins will have the following values:

- MOTO1 and MOTO2: put in high-impedance, PWM mode (standby 1 and reset: operating in standby 2); put in high-impedance, PDM mode (standby 1 and reset: operating in standby 2)

- SCL and SDA: no interaction; normal operation continues

- SCLK, WCLK, DATA, EF and DOBM: 3-state in both standby modes; normal operation continues after reset

- CRIN, CROUT, CL16 and CL11/4: no interaction; normal operation continues

- V1, V2/V3, V4, V5 and CFLG: no interaction; normal operation continues.

Table 1 Playback speeds

REGISTER B	REGISTER E	SELPLL	CRYSTAL FREQUENCY (MHz)			CL11 FREQUENCY (MHz)[1]
			33.8688	16.9344	8.4672	
00XX	0XXX	0	n = 1	–	–	11.2896
00XX	0XXX	1	–	–	n = 1	11.2896
01XX	0XXX	0	–	n = 1	–	5.6448
01XX	0XXX	1	–	n = 1	–	11.2896
10XX	0XXX	0	n = 2	–	–	11.2896
10XX	0XXX	1	–	–	n = 2	11.2896
11XX	0XXX	0	–	n = 2[2]	–	5.6448
11XX	0XXX	1	–	n = 2	–	11.2896
00XX	1XXX	0	n = 4[2]	–	–	11.2896
00XX	1XXX	1	–	–	n = 4	11.2896
01XX	1XXX	0	–	n = 4[2]	–	5.6448
01XX	1XXX	1	–	n = 4	–	11.2896

Notes

1. The CL11 output is always a 5.6448 MHz clock if a 16.9344 MHz external clock is used and SELPLL = 0. CL11 is available on the CL11/4 output, enabled by programming shadow register 3 (see Section 7.15.3).

2. Data capture performance is not optimized for this option.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

7.2 Crystal oscillator

The crystal oscillator is a conventional 2-pin design
operating between 8 and 35 MHz. This oscillator is
capable of operating with ceramic resonators and with
both fundamental and third overtone crystals. External
components should be used to suppress the fundamental
output of the third overtone crystals as shown in
Figs 3 and 4. Typical oscillation frequencies required are
8.4672, 16.9344 or 33.8688 MHz depending on the
internal clock settings used and whether or not the clock
multiplier is enabled.
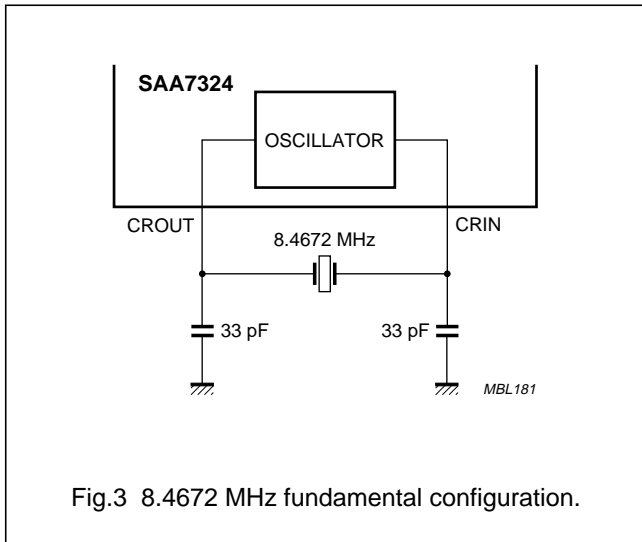
Fig.3 8.4672 MHz fundamental configuration.
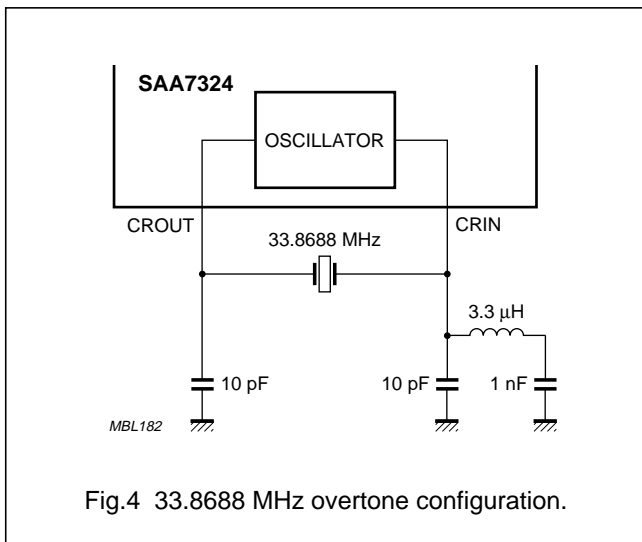
Fig.4 33.8688 MHz overtone configuration.

7.3 Data slicer and clock regenerator

The SAA7324 has an integrated slice level comparator
which can be clocked by the crystal frequency clock, or
4 times the crystal frequency clock (if SELPLL is set HIGH
while using a 16.9344 MHz crystal and register 4 is set
to 0XXX), or 8 times the crystal frequency clock
(if SELPLL is set HIGH while using an 8.4672 MHz crystal,
and register 4 is set to 0XXX). The slice level is controlled
by an internal current source applied to an external
capacitor under the control of the Digital Phase-Locked
Loop (DPLL).

Regeneration of the bit clock is achieved with an internal
fully digital PLL. No external components are required and
the bit clock is not output. The PLL has two registers
(8 and 9) for selecting bandwidth and equalization.
The PLL response is shown in Fig.5.

For certain applications an off-track input is necessary.
This is internally connected from the servo part (its polarity
can be changed by the foc_parm1 parameter), but may be
input via the V1 pin if selected by register C. If this flag is
HIGH, the SAA7324 will assume that its servo part is
following on the wrong track, and will flag all incoming
HF data as incorrect.
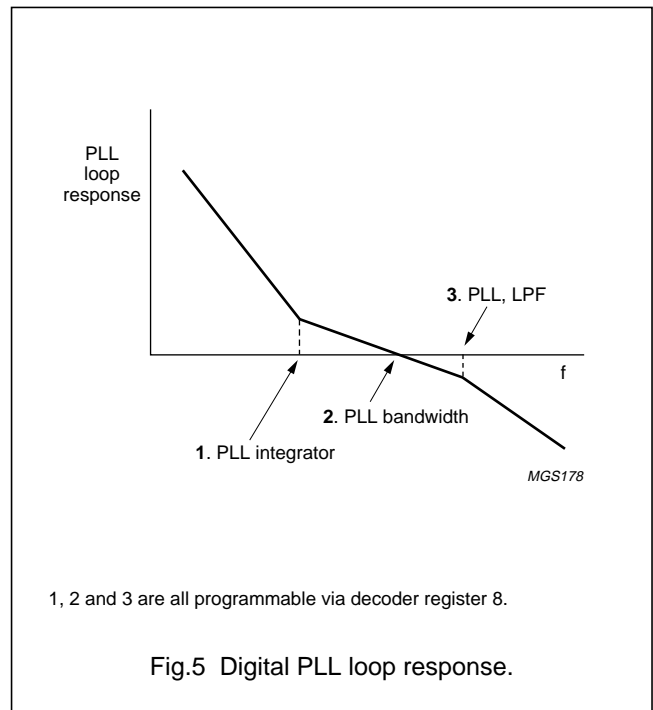
1, 2 and 3 are all programmable via decoder register 8.

Fig.5 Digital PLL loop response.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324
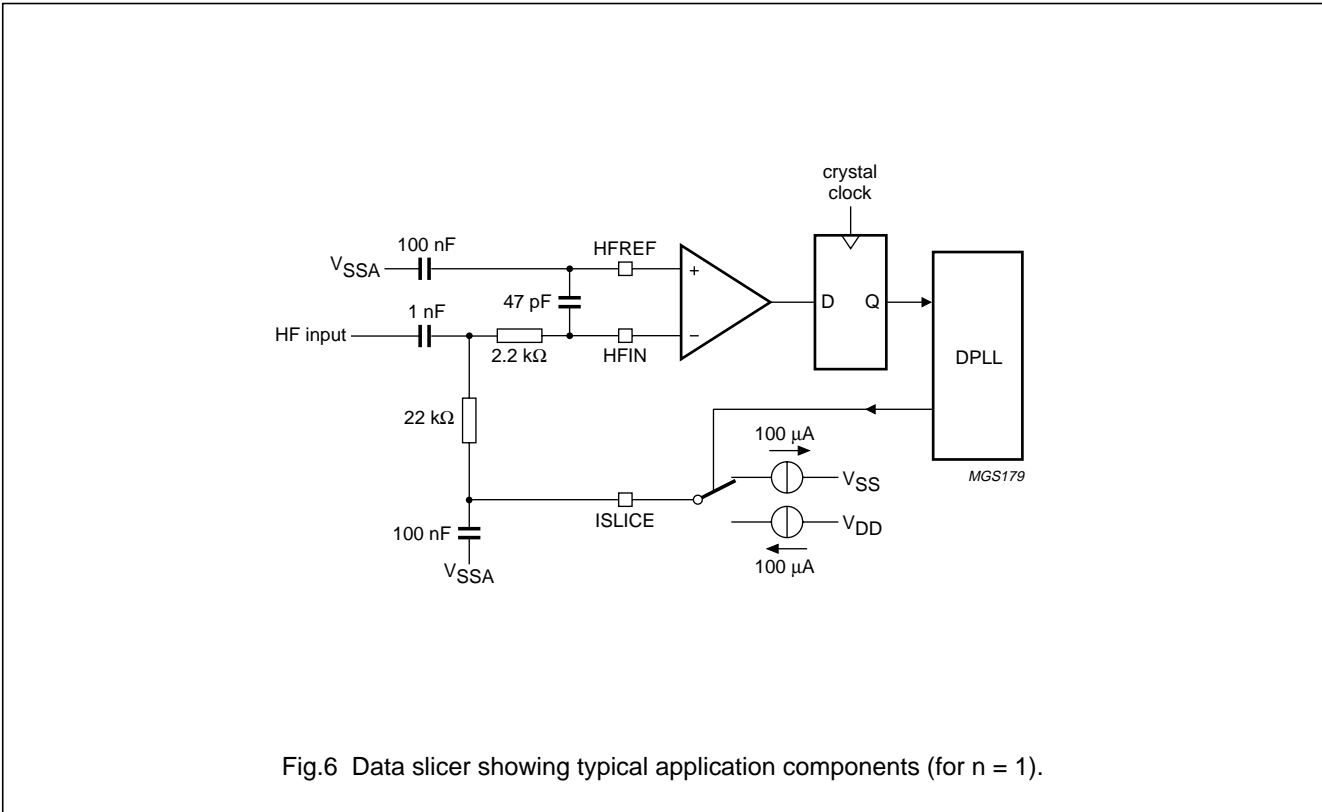
Fig.6 Data slicer showing typical application components (for n = 1).

7.4 Demodulator

7.4.1 FRAME SYNC PROTECTION

A double timing system is used to protect the demodulator
from erroneous sync patterns in the serial data.
The master counter is only reset if:

- A sync coincidence is detected; sync pattern occurs
  588 ±1 EFM clocks after the previous sync pattern

- A new sync pattern is detected within ±6 EFM clocks of
  its expected position.

The sync coincidence signal is also used to generate the
PLL lock signal, which is active HIGH after 1 sync
coincidence is found, and reset LOW if during 61
consecutive frames no sync coincidence is found. The PLL
lock signal can be accessed via the SDA or STATUS pins
selected by decoder registers 2 and 7.

Also incorporated in the demodulator is a Run Length 2
(RL2) correction circuit. Every symbol detected as RL2 will
be pushed back to RL3. To do this, the phase error of both
edges of the RL2 symbol are compared and the correction
is executed at the side with the highest error probability.

7.4.2 EFM DEMODULATION

The 14-bit EFM data and subcode words are decoded into
8-bit symbols.

V4

0: reg D = XX01

V4 SUBCODE
INTERFACE

RCK

CD GRAPHICS
INTERFACE

SBSY
SFSY
SUB

reg F

MICROCONTROLLER
INTERFACE

SDA

SUBCODE
PROCESSOR

EBU
INTERFACE

DOBM

output from
data slicer

DIGITAL PLL
AND
DEMODULATOR

decoder reg A

1: decoder reg A = XX0X
0: decoder reg A ≠ XX1X

1: shadow reg 7 = XX1X
0: shadow reg 7 = XX0X

FIFO

1: decoder reg 3 = XX10
   (1f$_S$ mode)
0: decoder reg 3 ≠ XX10

SCLK
WCLK
DATA
EF

1: no pre-emphasis detected
   OR reg D = 01XX
   (de-emphasis signal at V5)
0: pre-emphasis detected
   AND reg D ≠ 01XX

ONBOARD
DAC

LN
LP
RN
RP

V$_{neg}$

ERROR
CORRECTOR

FADE/MUTE/
INTERPOLATE

DIGITAL
FILTER

PHASE
COMPENSATION

I^{2}S/EIAJ BUS
INTERFACE

1: shadow reg 7 = XXX1
0: shadow reg 7 = XXX0

decoder reg 3

DE-EMPHASIS
FILTER

decoder
reg 3

1: shadow reg 7 = XX1X
0: shadow reg 7 = XX0X

KILL

KILL
V3

decoder reg C

1: decoder reg 3 ≠ 101X
0: decoder reg 3 = 101X
   (CD-ROM modes)

I^{2}S/EIAJ
LOOPBACK
INTERFACE

WCLI
SCLI
SDI

MGS180

Fig.7 Simplified data flow of decoder functions.

7.5 Subcode data processing

7.5.1 Q-CHANNEL PROCESSING

The 96-bit Q-channel word is accumulated in an internal
buffer. The last 16 bits are used internally to perform a
Cyclic Redundancy Check (CRC). If the data is good, the
SUBQREADY-I signal will go LOW. SUBQREADY-I can
be read via the SDA or STATUS pins, selected via decoder
register 2. Good Q-channel data may be read from SDA.

7.5.2 EIAJ 3 AND 4-WIRE SUBCODE (CD GRAPHICS) INTERFACES

Data from all the subcode channels (P-to-W) may be read
via the subcode interface, which conforms to
EIAJ CP-2401. The interface is enabled and configured as
either a 3 or 4-wire interface via decoder register F.

The subcode interface output formats are illustrated in
Fig.8, where the RCK signal is supplied by another device
such as a CD graphics decoder.

7.5.3 V4 SUBCODE INTERFACE

Data of subcode channels, Q-to-W, may be read via pin V4
if selected via decoder register D. The format is similar to
RS232 and is illustrated in Fig.9. The subcode sync word
is formed by a pause of (200/n) µs minimum. Each
subcode byte starts with a logic 1 followed by 7 bits
(Q-to-W). The gap between bytes is variable between
(11.3/n) µs and (90/n) µs.

The subcode data is also available in the EBU output
(DOBM) in a similar format.

Fig.8 EIAJ subcode (CD graphics) interface format.
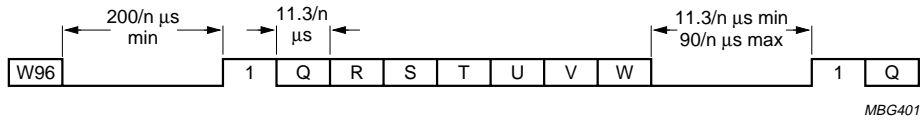
Fig.9 Subcode format and timing on pin V4.

7.6 FIFO and error corrector

The SAA7324 has a ±8 frame FIFO. The error corrector is a t = 2, e = 4 type, with error corrections on both C1 (32 symbol) and C2 (28 symbol) frames. Four symbols are used from each frame as parity symbols. This error corrector can correct up to two errors on the C1 level and up to four errors on the C2 level.

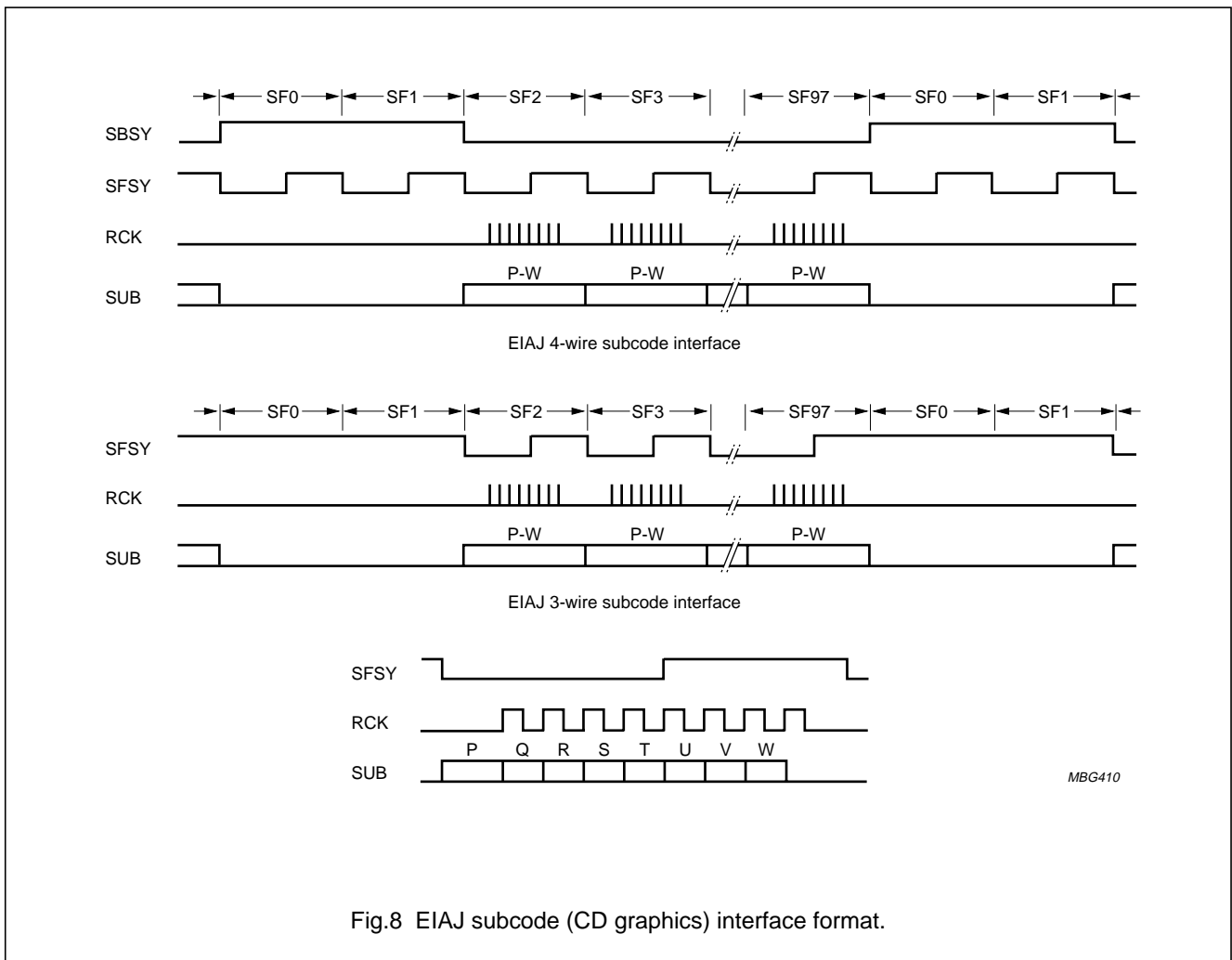The error corrector also contains a flag processor. Flags are assigned to symbols when the error corrector cannot ascertain if the symbols are definitely good. C1 generates output flags which are read after (de-interleaving) by C2, to help in the generation of C2 output flags.

The C2 output flags are used by the interpolator for concealment of uncorrectable errors. They are also output via the EBU signal (DOBM). The EF output will flag bytes in error in both audio and CD-ROM modes.

7.6.1 FLAGS OUTPUT (CFLG)

The flags output pin CFLG shows the status of the error corrector and interpolator and is updated every frame ($7.35 \times n$ kHz). In the SAA7324 chip a 1-bit flag is present on the CFLG pin as illustrated in Fig.10. This signal shows the status of the error corrector and interpolator.

The first flag bit, F1, is the absolute time sync signal, the FIFO-passed subcode sync and relates the position of the subcode sync to the audio data (DAC output). This flag may also be used in a super FIFO or in the synchronization of different players. The output flags can be made available at bit 4 of the EBU data format (LSB of the 24-bit data word), if selected by decoder register A.
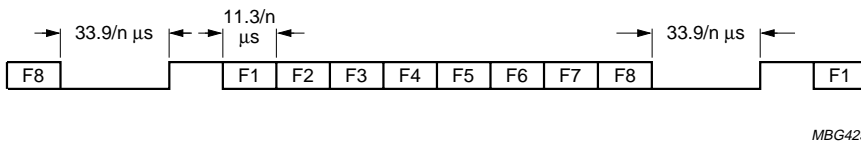
Fig.10 Flag output timing diagram.

Table 2 Output flags

F1	F2	F3	F4	F5	F6	F7	F8	DESCRIPTION
0	X	X	X	X	X	X	X	no absolute time sync
1	X	X	X	X	X	X	X	absolute time sync
X	0	0	X	X	X	X	X	C1 frame contained no errors
X	0	1	X	X	X	X	X	C1 frame contained 1 error
X	1	0	X	X	X	X	X	C1 frame contained 2 errors
X	1	1	X	X	X	X	X	C1 frame uncorrectable
X	X	X	0	0	X	X	0	C2 frame contained no errors
X	X	X	0	0	X	X	1	C2 frame contained 1 error
X	X	X	0	1	X	X	0	C2 frame contained 2 errors
X	X	X	0	1	X	X	1	C2 frame contained 3 errors
X	X	X	1	0	X	X	0	C2 frame contained 4 errors
X	X	X	1	1	X	X	1	C2 frame uncorrectable
X	X	X	X	X	0	0	X	no interpolations
X	X	X	X	X	0	1	X	at least one 1-sample interpolation
X	X	X	X	X	1	0	X	at least one hold and no interpolations
X	X	X	X	X	1	1	X	at least one hold and one 1-sample interpolation

7.7 Audio functions

7.7.1 DE-EMPHASIS AND PHASE LINEARITY

When pre-emphasis is detected in the Q-channel
subcode, the digital filter automatically includes a
de-emphasis filter section. When de-emphasis is not
required, a phase compensation filter section controls the
phase of the digital oversampling filter to $\leq \pm 1°$ within the
band 0 to 16 kHz. With de-emphasis the filter is not phase
linear.

If the de-emphasis signal is set to be available at V5,
selected via decoder register D, then the de-emphasis
filter is bypassed.

7.7.2 DIGITAL OVERSAMPLING FILTER

For optimizing performance with an external DAC, the
SAA7324 contains a 2 to 4 times oversampling IIR filter.
The filter specification of the 4 times oversampling filter is
given in Table 3.

These attenuations do not include the sample-and-hold at
the external DAC output or the DAC post filter. When using
the oversampling filter, the output level is scaled −0.5 dB
down to avoid overflow on full-scale sine wave inputs
(0 to 20 kHz).

Table 3 Filter specification

PASS BAND	STOP BAND	ATTENUATION
0 to 9 kHz	–	≤0.001 dB
19 to 20 kHz	–	≤0.03 dB
–	24 kHz	≥25 dB
–	24 to 27 kHz	≥38 dB
–	27 to 35 kHz	≥40 dB
–	35 to 64 kHz	≥50 dB
–	64 to 68 kHz	≥31 dB
–	68 kHz	≥35 dB
–	69 to 88 kHz	≥40 dB

7.7.3 CONCEALMENT

A 1-sample linear interpolator becomes active if a single
sample is flagged as erroneous but cannot be corrected.
The erroneous sample is replaced by a level midway
between the preceding and following samples. Left and
right channels have independent interpolators. If more
than one consecutive non-correctable sample is found, the
last good sample is held. A 1-sample linear interpolation is
then performed before the next good sample (see Fig.11).

In CD-ROM modes (i.e. the external DAC interface is
selected to be in a CD-ROM format) concealment is not
executed.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

7.7.4   MUTE, FULL-SCALE, ATTENUATION AND FADE

A digital level controller is present on the SAA7324 which
performs the functions of soft mute, full-scale, attenuation
and fade; these are selected via decoder register 0:

- Mute: signal reduced to 0 in a maximum of 128 steps;
  $(3/n)$ ms
- Attenuation: signal scaled by -12 dB
- Full-scale: ramp signal back to 0 dB level; from mute
  takes $(3/n)$ ms
- Fade: activates a 128 stage counter which allows the
  signal to be scaled up/down by 0.07 dB steps
    - 128 = full-scale
    - 120 = -0.5 dB (i.e. full-scale if oversampling filter
      used)
    - 32 = -12 dB
    - 0 = mute.

7.7.5   PEAK DETECTOR

The peak detector measures the highest audio level
(absolute value) on positive peaks for left and right
channels. The 8 most significant bits are output in the
Q-channel data in place of the CRC bits. Bits 81 to 88
contain the left peak value (bit 88 = MSB) and
bits 89 to 96 contain the right peak value (bit 96 = MSB).
The values are reset after reading Q-channel data via pin
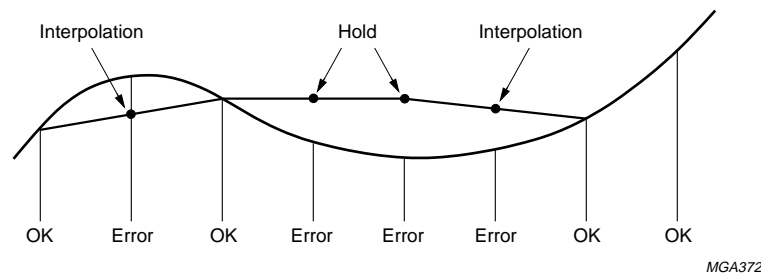SDA.

Fig.11 Concealment mechanism.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

7.8 DAC interface

7.8.1 INTERNAL BITSTREAM DIGITAL-TO-ANALOG CONVERTER (DAC)

The onboard bitstream DAC operates at a clock frequency of $96f_s$ and is designed for operation with an audio input at $1f_s$. Optimum performance is dependent on the application circuit used and careful consideration should be given to the recommended application circuits shown in Figs 38 and 39. The onboard DAC is controlled from shadow register 7 (see Section 7.15.3 for definition of shadow registers). This shadow register controls routing of data into the onboard DAC and also controls the DAC output pins, which can be held at zero when the onboard DAC is not required; see Table 4:

Audio data from the decoder part of the SAA7324 can be routed as described in Sections 7.8.1.1 and 7.8.1.2.

Table 4 Shadow register

SHADEN	SHADOW ADDRESS	REGISTER	DATA	FUNCTION	RESET
1	0111 (7H)	control of onboard DAC	XXX0	hold onboard DAC outputs at zero	reset
			XXX1	enable onboard DAC outputs	–
			XX0X	use external DAC or route audio data into onboard DAC (loopback mode)	reset
			XX1X	route audio data into onboard DAC (non-loopback mode)	–

7.8.1.1 Use onboard DAC

Setting shadow register 7 to XX11 will route audio data from the CD10 decoder into the internal DAC, and enables the DAC output pins (LN, LP, RN and RP). To enable the on-board DAC, the DAC interface format (set by register 3) must be set to 16-bit $1f_s$ mode, either I²S or EIAJ format. CD-ROM mode can also be used if interpolation is not required. The serial data output pins for interfacing with an external DAC (SCLK, WCLK, DATA and EF) are set to high-impedance.

7.8.1.2 Loopback external data into onboard DAC

The onboard DAC can also be set to accept serial data inputs from an external source, e.g. an Electronic Shock Absorption (ESA) IC. This is known as loopback mode and is enabled by setting shadow register 7 to XX01.

This enables the serial data output pins (SCLK, WCLK, DATA and EF) so that data can be routed from the SAA7324 to an external ESA system (or external DAC).

The serial data from an external ESA IC can then also be input to the onboard DAC on the SAA7324 by utilising the serial data input interface (SCLI, SDI and WCLI).

In this mode, a wide range of data formats to the external ESA IC can be programmed as shown in Table 5. However, the serial input on the SAA7324 will always expect the input data from the ESA IC to be 16-bit $1f_s$ and the same data format, either I²S-bus or EIAJ, as the serial output format (set by decoder register 3).

Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

SAA7324

7.8.2 EXTERNAL DAC INTERFACE

Audio data from the SAA7324 can be sent to an external DAC, identical to the SAA737x series. This is similar to the 'loopback' mode, but in this case the internal DAC outputs can be held at zero. i.e. shadow register 7 is set to XX00. The SAA7324 is compatible with a wide range of external DACs. Eleven formats are supported and are given in Table 5. Figures 12 and 13 show the Philips I^2S-bus and the EIAJ data formats respectively. When the decoder is operated in lock-to-disc mode, the SCLK frequency is dependent on the disc speed factor 'd'.

All formats are MSB first and f_s is $(44.1 \times n)$ kHz. The polarity of the WCLK and the data can be inverted; selectable by decoder register 7. It should be noted that EF is only a defined output in CD-ROM and $1f_s$ modes.

When using an external DAC (or when using the onboard DAC in non-loopback mode), the serial data inputs to the onboard DAC (SCLI, SDI and WCLI) should be left unconnected.
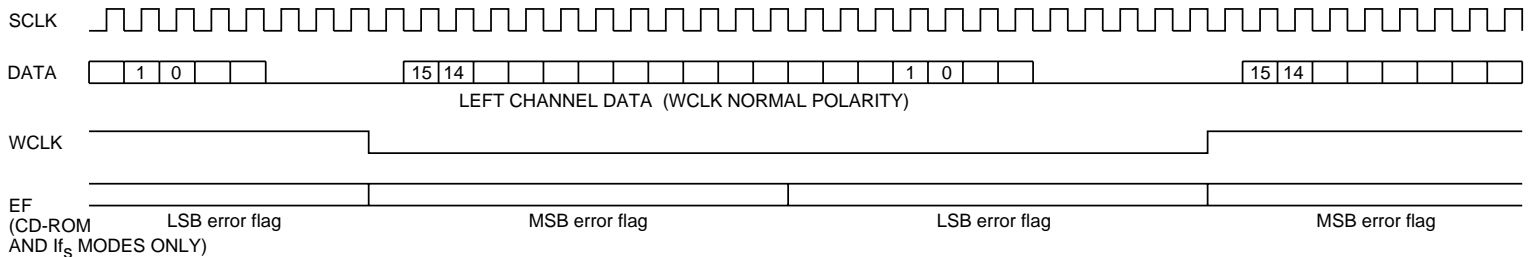
Table 5 DAC interface formats

REGISTER 3	SAMPLE FREQUENCY	NUMBER OF BITS	SCLK (MHz)	FORMAT	INTERPOLATION
1010	f_s	16	$2.1168 \times n$	CD-ROM (I^2S-bus)	no
1011	f_s	16	$2.1168 \times n$	CD-ROM (EIAJ)	no
1110	f_s	16/18[1]	$2.1168 \times n$	Philips I^2S-bus 16/18 bits[1]	yes
0010	f_s	16	$2.1168 \times n$	EIAJ 16 bits	yes
0110	f_s	18	$2.1168 \times n$	EIAJ 18 bits	yes
0000	$4f_s$	16	$8.4672 \times n$	EIAJ 16 bits	yes
0100	$4f_s$	18	$8.4672 \times n$	EIAJ 18 bits	yes
1100	$4f_s$	18	$8.4672 \times n$	Philips I^2S-bus 18 bits	yes
0011	$2f_s$	16	$4.2336 \times n$	EIAJ 16 bits	yes
0111	$2f_s$	18	$4.2336 \times n$	EIAJ 18 bits	yes
1111	$2f_s$	18	$4.2336 \times n$	Philips I^2S-bus 18 bits	yes

Note

1. In this mode the first 16 bits contain data, but if any of the fade, attenuate or de-emphasis filter functions are activated then the first 18 bits contain data.
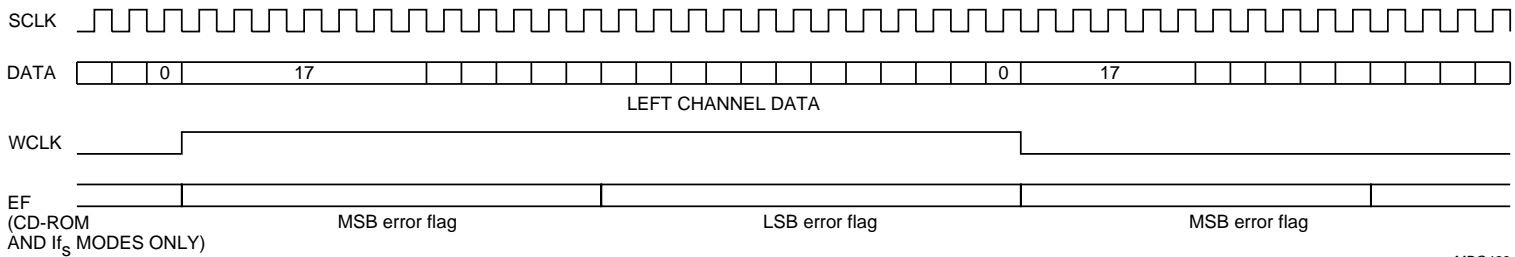
Philips Semiconductors

Product specification

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

2000 Jun 26

19

SCLK

DATA

| 1 | 0 | | | | 15 | 14 | | | | | | | | | | 1 | 0 | | | | 15 | 14 |

LEFT CHANNEL DATA (WCLK NORMAL POLARITY)

WCLK

EF
(CD-ROM
AND If$_S$ MODES ONLY)

LSB error flag

MSB error flag

LSB error flag

MSB error flag

MBG424

Fig.12 Philips I^{2}S-bus data format (16-bit word length shown).

SCLK

DATA

| 0 | 17 | | | | | | | | | 0 | 17 |

LEFT CHANNEL DATA

WCLK

EF
(CD-ROM
AND If$_S$ MODES ONLY)

MSB error flag

LSB error flag

MSB error flag

MBG423

Fig.13 EIAJ data format (18-bit word length shown).

7.9 EBU interface

The bi-phase mark digital output signal at pin DOBM is in
accordance with the format defined by the IEC 958
specification. Three different modes can be selected via
decoder register A:

- DOBM pin held LOW
- Data taken before concealment, mute and fade (must
  always be used for CD-ROM modes)
- Data taken after concealment, mute and fade.

7.9.1 FORMAT

The digital audio output consists of 32-bit words
('subframes') transmitted in bi-phase mark code (two
transitions for a logic 1 and one transition for a logic 0).
Words are transmitted in blocks of 384. The formats are
given in Table 6.

Table 6 Format

FUNCTION	BITS	DESCRIPTION
Sync	0 to 3	–
Auxiliary	4 to 7	not used; normally zero
Error flags	4	CFLG error and interpolation flags when selected by register A
Audio sample	8 to 27	first 4 bits not used (always zero); 2's complement; LSB = bit 12, MSB = bit 27
Validity flag	28	valid = logic 0
User data	29	used for subcode data (Q-to-W)
Channel status	30	control bits and category code
Parity bit	31	even parity for bits 4 to 30

Table 7 Description of Table 6

FUNCTION	DESCRIPTION
Sync	The sync word is formed by violation of the bi-phase rule and therefore does not contain any data. Its length is equivalent to 4 data bits. The 3 different sync patterns indicate the following situations: sync B: start of a block (384 words), word contains left sample; sync M: word contains left sample (no block start) and sync W: word contains right sample.
Audio sample	Left and right samples are transmitted alternately.
Validity flag	Audio samples are flagged (bit 28 = 1) if an error has been detected but was uncorrectable. This flag remains the same even if data is taken after concealment.
User data	Subcode bits Q-to-W from the subcode section are transmitted via the user data bit. This data is asynchronous with the block rate.
Channel status	The channel status bit is the same for left and right words. Therefore a block of 384 words contains 192 channel status bits. The category code is always CD. The bit assignment is given in Table 8.

Table 8 Bit assignment

FUNCTION	BITS	DESCRIPTION
Control	0 to 3	copy of CRC checked Q-channel control bits 0 to 3; bit 2 is logic 1 when copy permitted; bit 3 is logic 1 when recording has pre-emphasis
Reserved mode	4 to 7	always zero
Category code	8 to 15	CD: bit 8 = logic 1, all other bits = logic 0
Clock accuracy	28 to 29	set by register A; 10 = level I; 00 = level II; 01 = level III
Remaining	6 to 27 and 30 to 191	always zero

7.10 KILL circuit

The KILL circuit detects digital silence by testing for an
all-zero or all-ones data word in the left or right channel
prior to the digital filter. The output is switched to active
LOW when silence has been detected for at least 270 ms,
or if mute is active, or in CD-ROM modes. Two modes are
available which can be selected by decoder register C:

1. Pin KILL: KILL active LOW indicates silence detected
   on both left and right channels

2. Pin KILL: KILL active LOW indicates silence detected
   on left channel. V3 active LOW indicates silence
   detected on right channel.

It should be noted that when mute is active or in CD-ROM
modes the output(s) are switched LOW.

7.11 Audio features off

The audio features can be turned off (selected by decoder
register E) which affects the following functions:

- Digital filter, fade, peak detector, KILL circuit (but
  outputs KILL, V3 still active) are disabled

- V5 (if selected to be the de-emphasis flag output) and
  the EBU outputs become undefined.

It should be noted that the EBU output should be set LOW
prior to switching the audio features off and after switching
the audio features back on, a full-scale command should
be given.

7.12 The versatile pins interface

The SAA7324 has four pins that can be reconfigured for
different applications. One of these pins, V2/V3, can be
programmed as an input (V2) or as an output (V3). Control
of the V2/V3 pin is via shadow register 3; see Table 9.

Selection of the V2/V3 pin does not affect the function
programmed by decoder register C i.e. the V2 or V3 pin
can be changed from V2/V3 function either before or after
setting the desired function via decoder register 1100.
Selection of, for instance, a V3 function while the V2/V3
pin is set to V2 will not affect the V2 functionality.

The functions of these versatile pins is identical to the
SAA737x series. The functions of these versatile pins is
programmed by decoder registers C and D, as shown in
Table 10.

Table 9 V2 or V3 configuration

SHADEN	ADDRESS	REGISTER	DATA	FUNCTION	RESET
1	0011 (3H)	control of V2 or V3 pin	0XXX	V2/V3 pin configured as V2 input	reset
			1XXX	V2/V3 pin configured as V3 output (open-drain)	

Table 10 Pin applications

PIN NAME	PIN NUMBER	TYPE	REGISTER ADDRESS	REGISTER DATA	FUNCTION
V1	63	input	1100	XXX1	external off-track signal input
			–	XXX0	internal off-track signal used input may be read via decoder status bit; selected via register 2
V2	36	input	–	–	input may be read via decoder status bit; selected via register 2
V3	36	output	1100	XX0X	KILL output for right channel
			–	X01X	output = 0
			–	X11X	output = 1
V4	61	output	1101	0000	4-line motor drive (using V4 and V5)
			–	XX01	Q-to-W subcode output
			–	XX10	output = 0
			–	XX11	output = 1
V5	62	output	1101	01XX	de-emphasis output (active HIGH)
			–	10XX	output = 0
			–	11XX	output = 1

7.13 Spindle motor control

7.13.1 MOTOR OUTPUT MODES

The spindle motor speed is controlled by a fully integrated digital servo. Address information from the internal ± 8 frame FIFO and disc speed information are used to calculate the motor control output signals. Several output modes, selected by decoder register 6, are supported:

- Pulse density, 2-line (true complement output), $(1 \times n)$ MHz sample frequency
- PWM output, 2-line, $(22.05 \times n)$ kHz modulation frequency
- PWM output, 4-line, $(22.05 \times n)$ kHz modulation frequency
- CDV motor mode.

7.13.1.1 Pulse density output mode

In the pulse density mode the motor output pin (MOTO1) is the pulse density modulated motor output signal. A 50% duty factor corresponds with the motor not actuated, higher duty factors mean acceleration, lower mean braking. In this mode, the MOTO2 signal is the inverse of the MOTO1 signal. Both signals change state only on the edges of a $(1 \times n)$ MHz internal clock signal. Possible application diagrams are illustrated in Fig.14.

7.13.1.2 PWM output mode (2-line)

In the PWM mode the motor acceleration signal is put in pulse-width modulation form on the MOTO1 output. The motor braking signal is pulse-width modulated on the MOTO2 output. The timing is illustrated in Fig.15. A typical application diagram is illustrated in Fig.16.
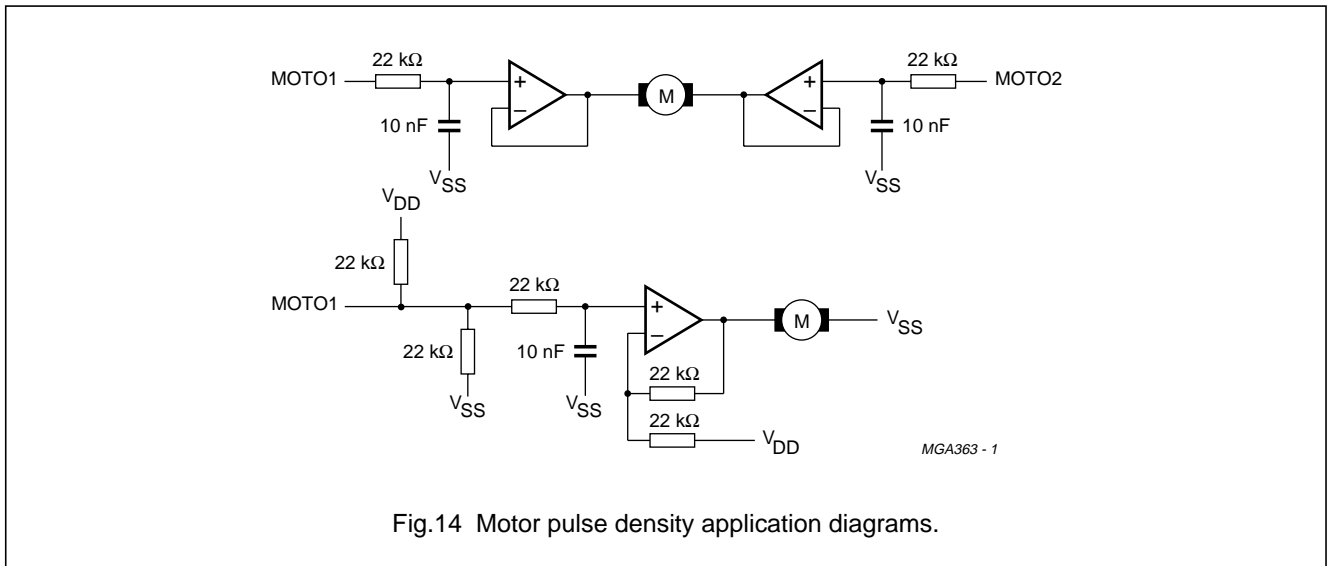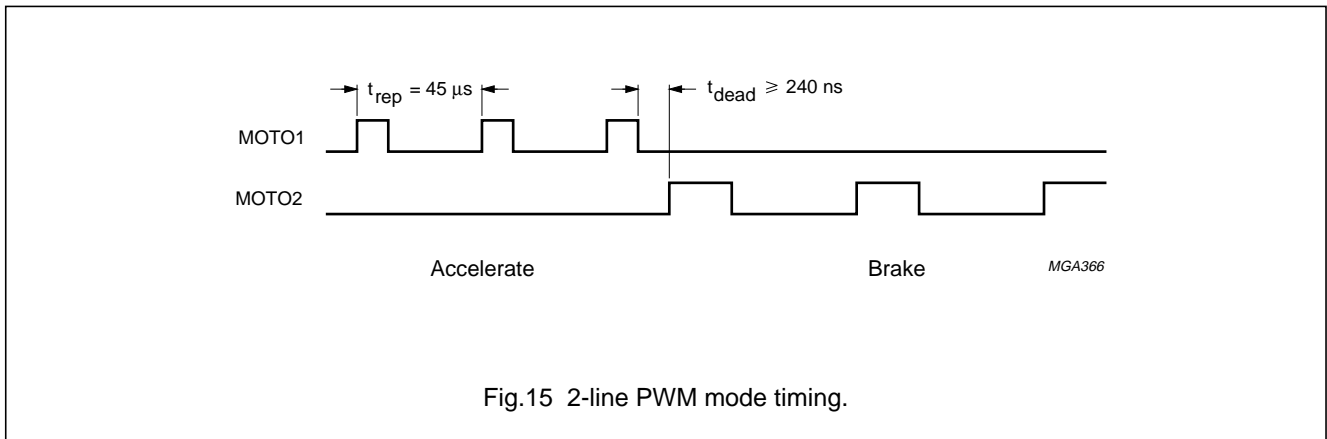

Fig.14 Motor pulse density application diagrams.

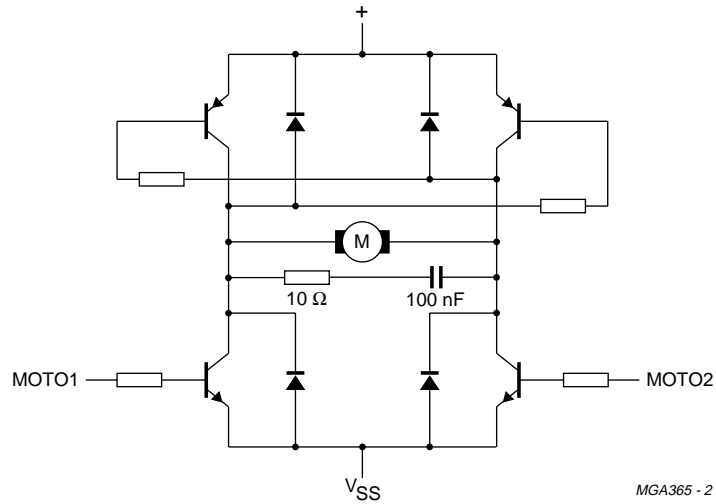Fig.15 2-line PWM mode timing.

Fig.16 Motor 2-line PWM mode application diagram.

7.13.1.3 PWM output mode (4-line)

Using two extra outputs from the versatile pins interface, it is possible to use the SAA7324 with a 4-input motor bridge. The timing is illustrated in Fig.17. A typical application diagram is illustrated in Fig.18.
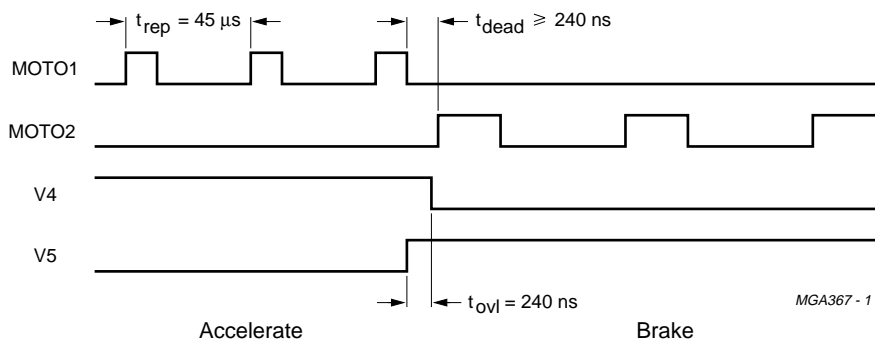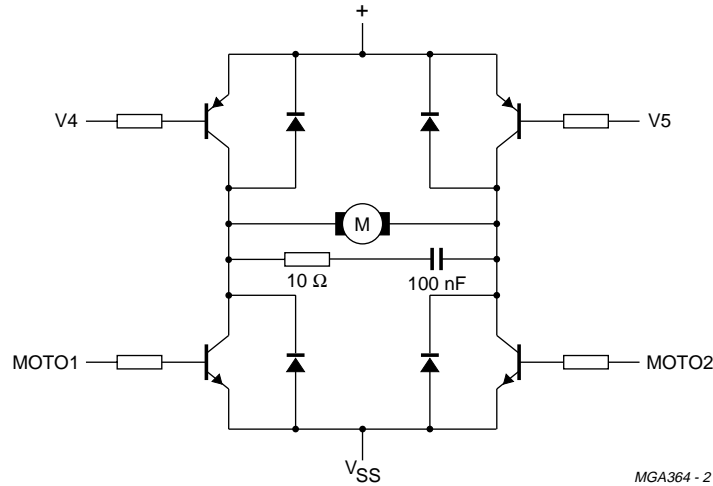

Fig.17 4-line PWM mode timing.

Fig.18 Motor 4-line PWM mode application diagram.

7.13.1.4   CDV/CAV output mode

In the CDV motor mode, the FIFO position will be put in
pulse-width modulated form on the MOTO1 pin [carrier
frequency $(300 \times d)$ Hz], where 'd' is the disc speed factor.
The PLL frequency signal will be put in pulse-density
modulated form (carrier frequency $4.23 \times n$ MHz) on the
MOTO2 pin. The integrated motor servo is disabled in this
mode.

The PWM signal on MOTO1 corresponds to a total
memory space of 20 frames, therefore the nominal FIFO
position (half full) will result in a PWM output of 60%.

In the lock-to-disc (CAV) mode the CDV motor mode is the
only mode that can be used to control the motor.

7.13.2   SPINDLE MOTOR OPERATING MODES

The operating modes of the motor servo is controlled by
decoder register 1 (see Table 11).

In the SAA7324 decoder there is an anti-windup mode for
the motor servo, selected via decoder register 1. When the
anti-windup mode is activated the motor servo integrator
will hold if the motor output saturates.

7.13.2.1   Power limit

In start mode 1, start mode 2, stop mode 1 and stop
mode 2, a fixed positive or negative voltage is applied to
the motor. This voltage can be programmed as a
percentage of the maximum possible voltage, via
register 6, to limit current drain during start and stop.

The following power limits are possible:

• 100% (no power limit), 75%, 50%, or 37% of maximum.

7.13.3   LOOP CHARACTERISTICS

The gain and crossover frequencies of the motor control
loop can be programmed via decoder registers 4 and 5.
The following parameter values are possible:

• Gains: 3.2, 4.0, 6.4, 8.0, 12.8, 16, 25.6 and 32

• Crossover frequency f_4: $0.5 \times n$ Hz, $0.7 \times n$ Hz,
  $1.4 \times n$ Hz and $2.8 \times n$ Hz

• Crossover frequency f_3: $0.85 \times n$ Hz, $1.71 \times n$ Hz and
  $3.42 \times n$ Hz.

It should be noted that the crossover frequencies f_3 and f_4
are scaled with the overspeed factor 'n' whereas the gains
are not.

7.13.4   FIFO OVERFLOW

If FIFO overflow occurs during Play mode (e.g.: as a result of motor rotational shock), the FIFO will be automatically reset
to 50% and the audio interpolator tries to conceal as much as possible to minimize the effect of data loss.

Table 11 Operating modes

MODE	DESCRIPTION
Start mode 1	The disc is accelerated by applying a positive voltage to the spindle motor. No decisions are involved and the PLL is reset. No disc speed information is available for the microcontroller.
Start mode 2	The disc is accelerated as in start mode 1, however the PLL will monitor the disc speed. When the disc reaches 75% of its nominal speed, the controller will switch to jump mode. The motor status signals selectable via register 2 are valid.
Jump mode	Motor servo enabled but FIFO kept reset at 50%, integrator is held. The audio is muted but it is possible to read the subcode. It should be noted that in the CD-ROM modes the data, on EBU and the I^{2}S-bus is not muted.
Jump mode 1	Similar to jump mode but motor integrator is kept at zero. Used for long jumps where there is a large change in disc speed.
Play mode	FIFO released after resetting to 50%. Audio mute released.
Stop mode 1	Disc is braked by applying a negative voltage to the motor. No decisions are involved.
Stop mode 2	The disc is braked as in stop mode 1 but the PLL will monitor the disc speed. As soon as the disc reaches 12% (or 6%, depending on the programmed brake percentage, via register E) of its nominal speed, the MOTSTOP status signal will go HIGH and switch the motor servo to Off mode.
Off mode	Motor not steered.
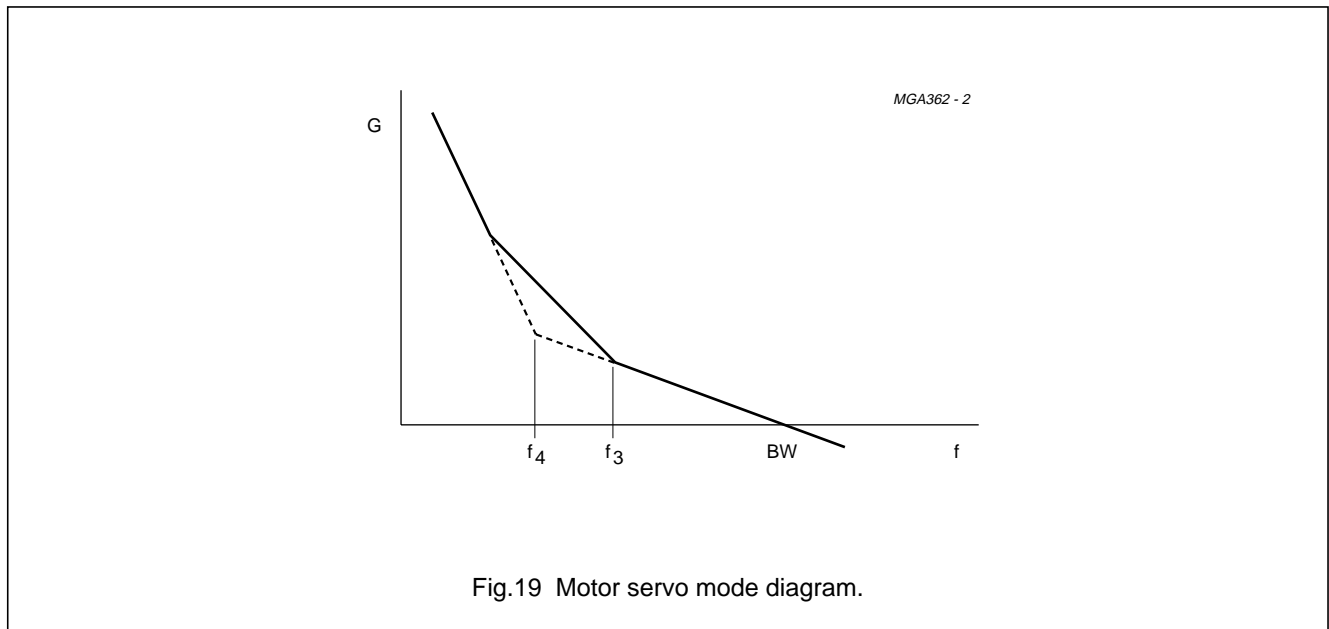
Fig.19 Motor servo mode diagram.

7.14 Servo part

7.14.1 DIODE SIGNAL PROCESSING

The photo detector in conventional two-stage three-beam
Compact Disc systems normally contains six discrete
diodes. Four of these diodes (three for single foucault
systems) carry the Central Aperture signal (CA) while the
other two diodes (satellite diodes) carry the radial tracking
information. The CA signal is processed into an HF signal
(for the decoder function) and LF signal (information for
the focus servo loop) before it is supplied to the SAA7324.

The analog signals from the central and satellite diodes
are converted into a digital representation using
Analog-to-Digital Converters (ADCs).

The ADCs are designed to convert unipolar currents into a
digital code. The dynamic range of the input currents is
adjustable within a given range, which is dependent on the
value of the external reference current (I_{ref}) resistor and
the values programmed in shadow registers A and C.
The magnitude of the signal currents for the central
aperture diodes D1 to D4 and the radial diodes R1 and R2
are programmed separately to sixteen separate current
ranges.

The maximum input currents with an external 30 kΩ
reference current resistor are given in Table 12.

Table 12 Shadow register settings to control diode input current ranges

SHADEN BIT	SHADOW REGISTER	ADDRESS	DATA	FUNCTION	INITIAL
1	A signal magnitude control for diodes D1 to D4	1010	0000	$(0.042).I_{ref}$ = 1.006 µA (nominal)	–
			0001	$(0.083).I_{ref}$ = 2.013 µA (nominal)	–
			0010	$(0.125).I_{ref}$ = 3.019 µA (nominal)	–
			0011	$(0.167).I_{ref}$ = 4.025 µA (nominal)	–
			0100	$(0.208).I_{ref}$ = 5.031 µA (nominal)	–
			0101	$(0.25).I_{ref}$ = 6.034 µA (nominal)	–
			0110	$(0.292).I_{ref}$ = 7.044 µA (nominal)	–
			0111	$(0.333).I_{ref}$ = 8.05 µA (nominal)	–
			1000	$(0.375).I_{ref}$ = 9.056 µA (nominal)	–
			1001	$(0.417).I_{ref}$ = 10.063 µA (nominal)	–
			1010	$(0.458).I_{ref}$ = 11.069 µA (nominal)	–
			1011	$(0.5).I_{ref}$ = 12.075 µA (nominal)	–
			1100	$(0.542).I_{ref}$ = 13.081 µA (nominal)	–
			1101	$(0.583).I_{ref}$ = 14.088 µA (nominal)	–
			1110	$(0.625).I_{ref}$ = 15.094 µA (nominal)	–
			1111	$(0.667).I_{ref}$ = 16.1 µA (nominal)	reset

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

SHADEN BIT	SHADOW REGISTER	ADDRESS	DATA	FUNCTION	INITIAL
1	C signal magnitude control for diodes R1 and R2	1100	0000	$(0.042).I_{ref}$ = 1.006 µA (nominal)	–
			0001	$(0.083).I_{ref}$ = 2.013 µA (nominal)	–
			0010	$(0.125).I_{ref}$ = 3.019 µA (nominal)	–
			0011	$(0.167).I_{ref}$ = 4.025 µA (nominal)	–
			0100	$(0.208).I_{ref}$ = 5.031 µA (nominal)	–
			0101	$(0.25).I_{ref}$ = 6.034 µA (nominal)	–
			0110	$(0.292).I_{ref}$ = 7.044 µA (nominal)	–
			0111	$(0.333).I_{ref}$ = 8.05 µA (nominal)	–
			1000	$(0.375).I_{ref}$ = 9.056 µA (nominal)	–
			1001	$(0.417).I_{ref}$ = 10.063 µA (nominal)	–
			1010	$(0.458).I_{ref}$ = 11.069 µA (nominal)	–
			1011	$(0.5).I_{ref}$ = 12.075 µA (nominal)	–
			1100	$(0.542).I_{ref}$ = 13.081 µA (nominal)	–
			1101	$(0.583).I_{ref}$ = 14.088 µA (nominal)	–
			1110	$(0.625).I_{ref}$ = 15.094 µA (nominal)	–
			1111	$(0.667).I_{ref}$ = 16.1 µA (nominal)	reset

7.14.2   SIGNAL CONDITIONING

The digital codes retrieved from the ADCs are applied to
logic circuitry to obtain the various control signals.
The signals from the central aperture diodes are
processed to obtain a normalised focus error signal.

$$FE_n = \frac{D1 - D2}{D1 + D2} - \frac{D3 - D4}{D3 + D4}$$

where the detector set-up is assumed to be as shown in
Fig.20.

In the event of single Foucault focusing method, the signal
conditioning can be switched under software control such
that the signal processing is as follows:

$$FE_n = 2 \times \frac{D1 - D2}{D1 + D2}$$

The error signal, FE_n, is further processed by a
Proportional Integral and Differential (PID) filter section.

A Focus OK (FOK) flag is generated by means of the
central aperture signal and an adjustable reference level.
This signal is used to provide extra protection for the
Track-Loss (TL) generation, the focus start-up procedure
and the dropout detection.

The radial or tracking error signal is generated by the
satellite detector signals R1 and R2. The radial error
signal can be formulated as follows:

RE_s = (R1 − R2) × re_gain + (R1 + R2) × re_offset

where the index 's' indicates the automatic scaling
operation which is performed on the radial error signal.
This scaling is necessary to avoid non-optimum dynamic
range usage in the digital representation and reduces the
radial bandwidth spread. Furthermore, the radial error
signal will be made free from offset during start-up of the
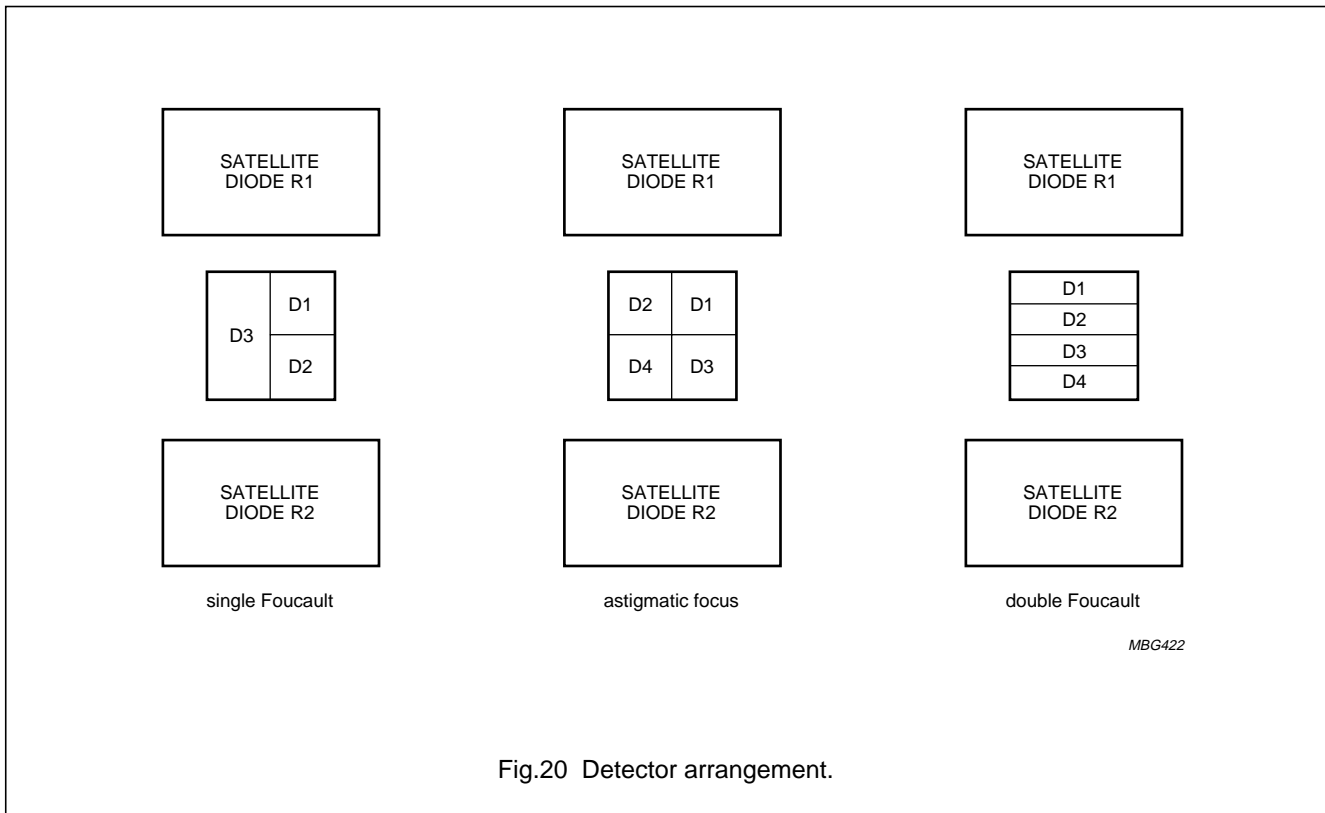disc.

The four signals from the central aperture detectors,
together with the satellite detector signals generate a
Track Position Signal (TPI) which can be formulated as
follows:

TPI = sign [(D1 + D2 + D3 + D4) − (R1 + R2) × sum_gain]

where the weighting factor sum_gain is generated
internally by the SAA7324 during initialization.

Fig.20 Detector arrangement.

Labels within figure: SATELLITE DIODE R1, SATELLITE DIODE R2, single Foucault, astigmatic focus, double Foucault, MBG422

7.14.3 FOCUS SERVO SYSTEM

7.14.3.1 *Focus start-up*

Five initially loaded coefficients influence the start-up
behaviour of the focus controller. The automatically
generated triangular voltage can be influenced by
3 parameters; for height (ramp_height) and DC offset
(ramp_offset) of the triangle and its steepness
(ramp_incr).

For protection against false focus point detections two
parameters are available which are an absolute level on
the CA signal (CA_start) and a level on the FE_n signal
(FE_start). When this CA level is reached the FOK signal
becomes true.

If the FOK signal is true and the level on the FE_n signal is
reached, the focus PID is enabled to switch-on when the
next zero crossing is detected in the FE_n signal.

7.14.3.2 *Focus position control loop*

The focus control loop contains a digital PID controller
which has 5 parameters that are available to the user.
These coefficients influence the integrating (foc_int),
proportional (foc_lead_length, part of foc_parm3) and
differentiating (foc_pole_lead, part of foc_parm1) action of
the PID and a digital low-pass filter (foc_pole_noise, part
of foc_parm2) following the PID. The fifth coefficient
foc_gain influences the loop gain.

7.14.3.3 *Dropout detection*

This detector can be influenced by one parameter
(CA_drop). The FOK signal will become false and the
integrator of the PID will hold if the CA signal drops below
this programmable absolute CA level. When the FOK
signal becomes false it is assumed, initially, to be caused
by a black dot.

7.14.3.4 Focus loss detection and fast restart

Whenever FOK is false for longer than approximately
3 ms, it is assumed that the focus point is lost. A fast
restart procedure is initiated which is capable of restarting
the focus loop within 200 to 300 ms depending on the
programmed coefficients of the microcontroller.

7.14.3.5 Focus loop gain switching

The gain of the focus control loop (foc_gain) can be
multiplied by a factor of 2 or divided by a factor of 2 during
normal operation. The integrator value of the PID is
corrected accordingly. The differentiating (foc_pole_lead)
action of the PID can be switched at the same time as the
gain switching is performed.

7.14.3.6 Focus automatic gain control loop

The loop gain of the focus control loop can be corrected
automatically to eliminate tolerances in the focus loop.
This gain control injects a signal into the loop which is used
to correct the loop gain. Since this decreases the optimum
performance, the gain control should only be activated for
a short time (for example, when starting a new disc).

7.14.4 RADIAL SERVO SYSTEM

7.14.4.1 Level initialization

During start-up an automatic adjustment procedure is
activated to set the values of the radial error gain (re_gain),
offset (re_offset) and satellite sum gain (sum_gain) for TPI
level generation. The initialization procedure runs in a
radial open loop situation and is ≤300 ms. This start-up
time period may coincide with the last part of the motor
start-up time period:

- Automatic gain adjustment: as a result of this
  initialization the amplitude of the RE signal is adjusted to
  within ±10% around the nominal RE amplitude

- Offset adjustment: the additional offset in RE due to the
  limited accuracy of the start-up procedure is less than
  ±50 nm

- TPI level generation: the accuracy of the initialization
  procedure is such that the duty factor range of TPI
  becomes 0.4 < duty factor < 0.6 (default duty
  factor = TPI HIGH/TPI period).

7.14.4.2 Sledge control

The microcontroller can move the sledge in both directions
via the steer sledge command.

7.14.4.3 Tracking control

The actuator is controlled using a PID loop filter with user
defined coefficients and gain. For stable operation
between the tracks, the S-curve is extended over 0.75 of
the track. On request from the microcontroller, S-curve
extension over 2.25 tracks is used, automatically changing
to access control when exceeding those 2.25 tracks.

Both modes of S-curve extension make use of a
track-count mechanism. In this mode, track counting
results in an 'automatic return-to-zero track', to avoid
major music rhythm disturbances in the audio output for
improved shock resistance. The sledge is continuously
controlled, or provided with step pulses to reduce power
consumption using the filtered value of the radial PID
output. Alternatively, the microcontroller can read the
average voltage on the radial actuator and provide the
sledge with step pulses to reduce power consumption.
Filter coefficients of the continuous sledge control can be
preset by the user.

7.14.4.4 Access

The access procedure is divided into two different modes
(see Table 13), depending on the requested jump size.

Table 13 Access modes

ACCESS TYPE	JUMP SIZE[1]	ACCESS SPEED
Actuator jump	1 - brake_distance	decreasing velocity
Sledge jump	brake_distance - 32768	maximum power to sledge[1]

Note

1. Microcontroller presettable.

The access procedure makes use of a track counting
mechanism, a velocity signal based on a fixed number of
tracks passed within a fixed time interval, a velocity set
point calculated from the number of tracks to go and a user
programmable parameter indicating the maximum sledge
performance.

If the number of tracks remaining is greater than the
brake_distance then the sledge jump mode should be
activated or, the actuator jump should be performed.
The requested jump size together with the required sledge
breaking distance at maximum access speed defines the
brake_distance value.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

During the actuator jump mode, velocity control with a PI controller is used for the actuator. The sledge is then continuously controlled using the filtered value of the radial PID output. All filter parameters (for actuator and sledge) are user programmable.

In the sledge jump mode maximum power (user programmable) is applied to the sledge in the correct direction while the actuator becomes idle (the contents of the actuator integrator leaks to zero just after the sledge jump mode is initiated). The actuator can be electronically damped during sledge jump. The gain of the damping loop is controlled via the hold_mult parameter.

The fast track jumping circuitry can be enabled/disabled via the xtra_preset parameter.

7.14.4.5 *Radial automatic gain control loop*

The loop gain of the radial control loop can be corrected automatically to eliminate tolerances in the radial loop. This gain control injects a signal into the loop which is used to correct the loop gain. Since this decreases the optimum performance, the gain control should only be activated for a short time (for example, when starting a new disc).

This gain control differs from the level initialization. The level initialization should be performed first.
The disadvantage of using the level initialization without the gain control is that only tolerances from the front-end are reduced.

7.14.5 OFF-TRACK COUNTING

The Track Position Signal (TPI) is a flag which is used to indicate whether the radial spot is positioned on the track, with a margin of $\pm\frac{1}{4}$ of the track-pitch. In combination with the Radial Polarity flag (RP) the relative spot position over the tracks can be determined.

These signals are, however, afflicted with some uncertainties caused by:

- Disc defects such as scratches and fingerprints
- The HF information on the disc, which is considered as noise by the detector signals.

In order to determine the spot position with sufficient accuracy, extra conditions are necessary to generate a Track Loss signal (TL) and an off-track counter value. These extra conditions influence the maximum speed and this implies that, internally, one of the following three counting states is selected:

1. Protected state: used in normal play situations. A good protection against false detection caused by disc defects is important in this state.

2. Slow counting state: used in low velocity track jump situations. In this state a fast response is important rather than the protection against disc defects (if the phase relationship between TL and RP of $\frac{1}{2}\pi$ radians is affected too much, the direction cannot then be determined accurately).

3. Fast counting state: used in high velocity track jump situations. Highest obtainable velocity is the most important feature in this state.

7.14.6 DEFECT DETECTION

A defect detection circuit is incorporated into the SAA7324. If a defect is detected, the radial and focus error signals may be zeroed, resulting in better playability. The defect detector can be switched off, applied only to focus control or applied to both focus and radial controls under software control (part of foc_parm1).

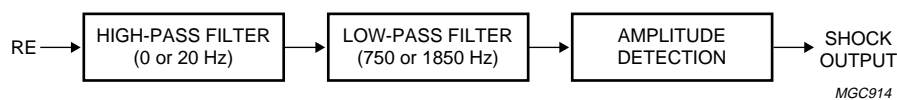The defect detector (see Fig.21) has programmable set points selectable by the parameter defect_parm.
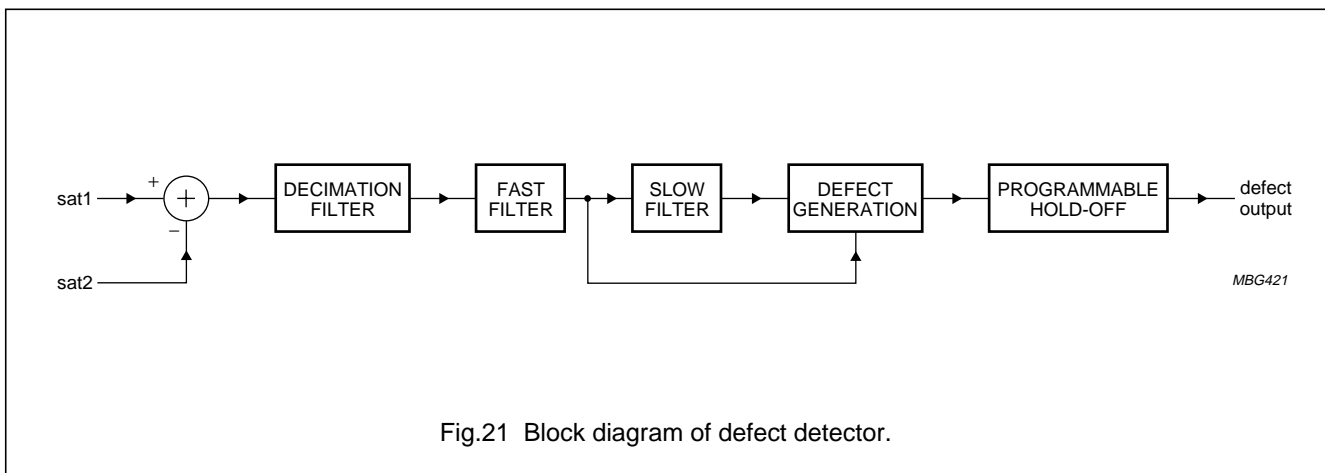
Fig.21 Block diagram of defect detector.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

7.14.7 OFF-TRACK DETECTION

During active radial tracking, off-track detection has been realised by continuously monitoring the off-track counter value. The off-track flag becomes valid whenever the off-track counter value is not equal to zero. Depending on the type of extended S-curve, the off-track counter is reset after 0.75 extend or at the original track in the 2.25 track extend mode.

7.14.8 HIGH-LEVEL FEATURES

7.14.8.1 Interrupt mechanism and STATUS pin

The STATUS pin is an output which is active LOW, its output is selected by decoder register 7 to be either the decoder status bit (active LOW) selected by decoder register 2 (only available in 4-wire bus mode) or the interrupt signal generated by the servo part.

Eight signals from the interrupt status register are selectable from the servo part via the interrupt_mask parameter. The interrupt is reset by sending the read high-level status command. The 8 signals are as follows:

- Focus lost: dropout of longer than 3 ms
- Subcode ready
- Subcode absolute seconds changed
- Subcode discontinuity detected: new subcode time before previous subcode time, or more than 10 frames later than previous subcode time
- Radial error: during radial on-track, no new subcode frame occurs within time defined by the 'playwatchtime' parameter; during radial jump, less than 4 tracks have been crossed during time defined by the 'jumpwatchtime' parameter
- Autosequencer state change
- Autosequencer error
- Subcode interface blocked: the internal decoder interface is being used.

It should be noted that if the STATUS pin output is selected via decoder register 2 and either the microcontroller writes a different value to decoder register 2 or the decoder interface is enabled then the STATUS output will change.

7.14.8.2 Decoder interface

The decoder interface allows decoder registers 0 to F to be programmed and subcode Q-channel data to be read via servo commands. The interface is enabled/disabled by the preset latch command (and the xtra_preset parameter).

7.14.8.3 Automatic error handling

Three Watchdogs are present:

- Focus: detects focus dropout of longer than 3 ms, sets focus lost interrupt, switches off radial and sledge servos, disables drive to disc motor
- Radial play: started when radial servo is in on-track mode and a first subcode frame is found; detects when maximum time between two subcode frames exceeds the time set by playwatchtime parameter; then sets radial error interrupt, switches radial and sledge servos off, puts disc motor in jump mode
- Radial jump: active when radial servo is in long jump or short jump modes; detects when the off-track counter value decreases by less than 4 tracks between two readings (time interval set by jumpwatchtime parameter); then sets radial jump error, switches radial and sledge servos off to cancel jump.

The focus Watchdog is always active, the radial Watchdogs are selectable via the radcontrol parameter.

7.14.8.4 Automatic sequencers and timer interrupts

Two automatic sequencers are implemented (and must be initialized after power-on):

- Autostart sequencer: controls the start-up of focus, radial and motor
- Autostop sequencer: brakes the disc and shuts down servos.

When the automatic sequencers are not used it is possible to generate timer interrupts, defined by the time_parameter coefficient.

7.14.8.5 High-level status

The read high-level status command can be used to obtain the interrupt, decoder, autosequencer status registers and the motor start time. Use of the read high-level status command clears the interrupt status register, and re-enables the subcode read via a servo command.

7.14.9 DRIVER INTERFACE

The control signals (pins RA, FO and SL) for the mechanism actuators are pulse density modulated. The modulating frequency can be set to either 1.0584 (DSD mode) or 2.1168 MHz; controlled via the xtra_preset parameter. An analog representation of the output signals can be achieved by connecting a 1st-order low-pass filter to the outputs.

During reset (i.e. RESET pin is held LOW) the
RA, FO and SL pins are high-impedance.

7.14.10 LASER INTERFACE

The LDON pin (open-drain output) is used to switch the
laser off and on. When the laser is on, the output is
high-impedance. The action of the LDON pin is controlled
by the xtra_preset parameter; the pin is automatically
driven if the focus control loop is active.

7.14.11 RADIAL SHOCK DETECTOR

The shock detector (see Fig.22) can be switched on during
normal track following, and detects within an adjustable
frequency whether disturbances in the radial spot position
relative to the track exceed an adjustable level (controlled
by shock_level).

Every time the radial tracking error exceeds this level the
radial control bandwidth is switched to twice its original
bandwidth and the loop gain is increased by a factor of 4.

The shock detection level is adjustable in 16 steps from
0% to 100% of the traverse radial amplitude which is sent
to an amplitude detection unit via an adjustable band-pass
filter (controlled by sledge_parm1); lower corner frequency
can be set at either 0 or 20 Hz, and upper corner
frequency at 750 or 1850 Hz. The shock detector is
switched off automatically during jump mode.

7.15 Microcontroller interface

Communication on the microcontroller interface can be
set-up in two different modes:

- 4-wire bus mode: protocol compatible with SAA7345
  (CD6) and TDA1301 (DSIC2) where:
  - SCL = serial clock
  - SDA = serial data
  - RAB = R/$\overline{\text{W}}$ control and data strobe (active HIGH) for
    writing to decoder registers 0 to F, reading status bit
    selected via decoder register 2 and reading
    Q-channel subcode
  - SILD = $\overline{\text{R}}$/W control and data strobe (active LOW) for
    servo commands.

- I^{2}C-bus mode: I^{2}C-bus protocol where the SAA7324
  behaves as slave device, activated by setting
  RAB = HIGH and SILD = LOW where:
  - I^{2}C-bus slave address (write mode) = 30H
  - I^{2}C-bus slave address (read mode) = 31H
  - Maximum data transfer rate = 400 kbits/s.

It should be noted that only servo commands can be used
therefore, writing to decoder registers 0 to F, reading
decoder status and reading Q-channel subcode data must
be performed by servo commands.

RE → HIGH-PASS FILTER (0 or 20 Hz) → LOW-PASS FILTER (750 or 1850 Hz) → AMPLITUDE DETECTION → SHOCK OUTPUT

MGC914

Fig.22 Block diagram of radial shock detector.

7.15.1   MICROCONTROLLER INTERFACE (4-WIRE BUS MODE)

7.15.1.1   Writing data to registers 0 to F

The sixteen 4-bit programmable configuration registers,
0 to F (see Table 14), can be written to via the
microcontroller interface using the protocol shown in
Fig.23.

It should be noted that SILD must be held HIGH; A3 to A0
identifies the register number and D3 to D0 is the data.
The data is latched into the register on the LOW-to-HIGH
transition of RAB.

7.15.1.2   Writing repeated data to registers 0 to F

The same data can be repeated several times (e.g. for a
fade function) by applying extra RAB pulses as shown in
Fig.24. It should be noted that SCL must stay HIGH
between RAB pulses.

7.15.1.3   Reading decoder status information on SDA

There are several internal status signals, selected via
register 2, which can be made available on the SDA line:

SUBQREADY-I: LOW if new subcode word is ready in
Q-channel register

MOTSTART1: HIGH if motor is turning at 75% or more
of nominal speed

MOTSTART2: HIGH if motor is turning at 50% or more
of nominal speed

MOTSTOP: HIGH if motor is turning at 12% or less of
nominal speed; can be set to indicate 6% or less
(instead of 12% or less) via register E

PLL lock: HIGH if sync coincidence signals are found

V1: follows input on pin V1

V2: follows input on pin V2

MOTOR-OV: HIGH if the motor servo output stage
saturates

FIFO-OV: HIGH if FIFO overflows

SHOCK: $\overline{\text{MOTSTART2}}$ + $\overline{\text{PLL Lock}}$ + MOTOR-OV +
FIFO-OV + servo interrupt signal + OTD (HIGH if shock
detected)

LA-SHOCK: latched SHOCK signal.

The status read protocol is shown in Fig.25. It should be
noted that SILD must be held HIGH.

7.15.1.4   Reading Q-channel subcode

To read the Q-channel subcode direct in the 4-wire bus
mode, the SUBQREADY-I signal should be selected as
status signal. The subcode read protocol is illustrated in
Fig.26.

It should be noted that SILD must be held HIGH; after
subcode read starts, the microcontroller may take as long
as it wants to terminate the read operation. When enough
subcode has been read (1 to 96 bits), terminate reading by
pulling RAB LOW.

Alternatively, the Q-channel subcode can be read using a
servo command as follows:

• Use the read high-level status command to monitor the
  subcode ready signal

• Send the read subcode command and read the required
  number of bytes (up to 12)

• Send the read high-level status command; to re-enable
  the decoder interface.

7.15.1.5   Behaviour of the SUBQREADY-I signal

When the CRC of the Q-channel word is good, and no
subcode is being read, the SUBQREADY-I status signal
will react as shown in Fig.27. When the CRC is good and
the subcode is being read, the timing in Fig.28 applies.

If t_1 (SUBQREADY-I status LOW to end of subcode read)
is below 2.6/n ms, then t_2 = 13.1/n ms (i.e. the
microcontroller can read all subcode frames if it completes
the read operation within 2.6/n ms after the subcode is
ready). If these criteria are not met, it is only possible to
guarantee that t_3 will be below 26.2/n ms (approximately).

If subcode frames with failed CRCs are present, the
t_2 and t_3 times will be increased by 13.1/n ms for each
defective subcode frame.

It should be noted that in the lock-to-disc mode 'n' is
replaced by 'd', which is the disc speed factor.

7.15.1.6   Write servo commands

A write data command is used to transfer data (a number
of bytes) from the microcontroller, using the protocol
shown in Fig.29. The first of these bytes is the command
byte and the following are data bytes; the number
(between 1 and 7) depends on the command byte.

It should be noted that RAB must be held LOW; the command or data is interpreted by the SAA7324 after the HIGH-to-LOW transition of SILD; there must be a minimum time of 70 μs between SILD pulses.

7.15.1.7 Writing repeated data in servo commands

The same data byte can be repeated by applying extra SILD pulses as illustrated in Fig.30. SCL must be HIGH between the SILD pulses.

7.15.1.8 Read servo commands

A read data command is used to transfer data (status information) to the microcontroller, using the protocol shown in Fig.31. The first byte written determines the type of command. After this byte a variable number of bytes can be read. It should be noted that RAB must be held LOW; after the end of the command byte (LOW-to-HIGH transition on SILD) there must be a delay of 70 μs before reading data is started (i.e. the next HIGH-to-LOW transition on SILD); there must be a minimum time of 70 μs between SILD pulses.

7.15.2 MICROCONTROLLER INTERFACE (I^{2}C-BUS MODE)

Bytes are transferred over the interface in groups (i.e. servo commands) of which there are two types: write data commands and read data commands.

The sequence for a write data command (that requires 3 data bytes) is as follows:

1. Send START condition
2. Send address 30H (write)
3. Write command byte
4. Write data byte 1
5. Write data byte 2
6. Write data byte 3
7. Send STOP condition.

It should be noted that more than one command can be sent in one write sequence.

The sequence for a read data command (that reads 2 data bytes) is as follows:

1. Send START condition
2. Send address 30H (write)
3. Write command byte
4. Send STOP condition
5. Send START condition
6. Send address 31H (read)
7. Read data byte 1
8. Read data byte 2
9. Send STOP condition.

It should be noted that the timing constraints specified for the read and write servo commands must still be adhered to.
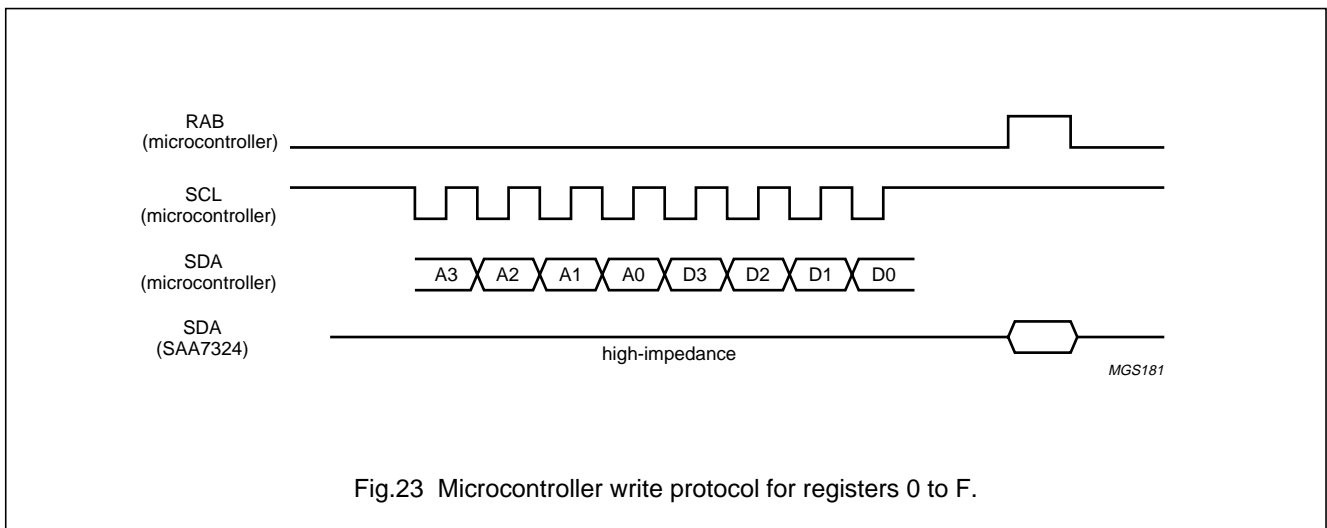
Fig.23 Microcontroller write protocol for registers 0 to F.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)
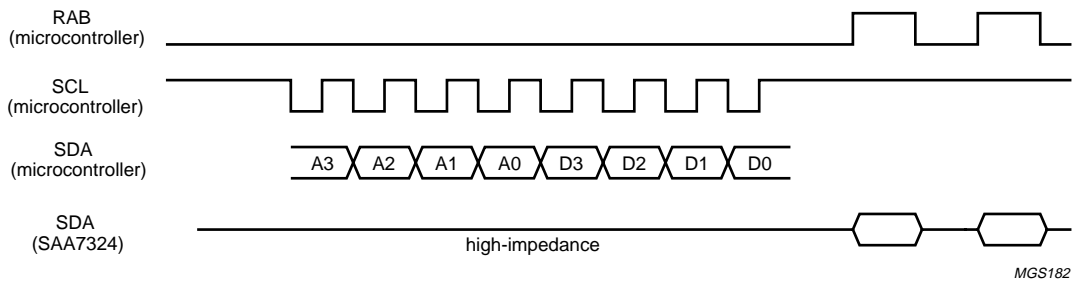
SAA7324

Fig.24 Microcontroller write protocol for registers 0 to F (repeat mode).
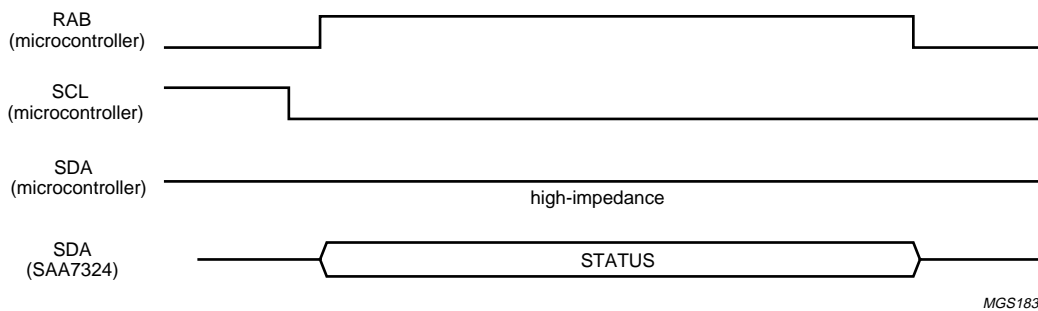
Fig.25 Microcontroller read protocol for decoder status on SDA.
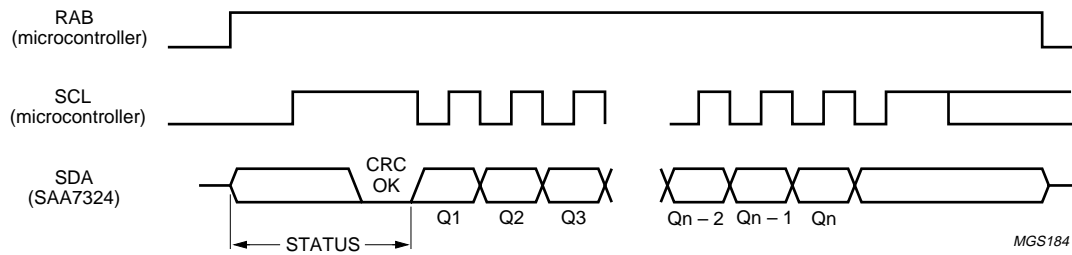
Fig.26 Microcontroller protocol for reading Q-channel subcode.
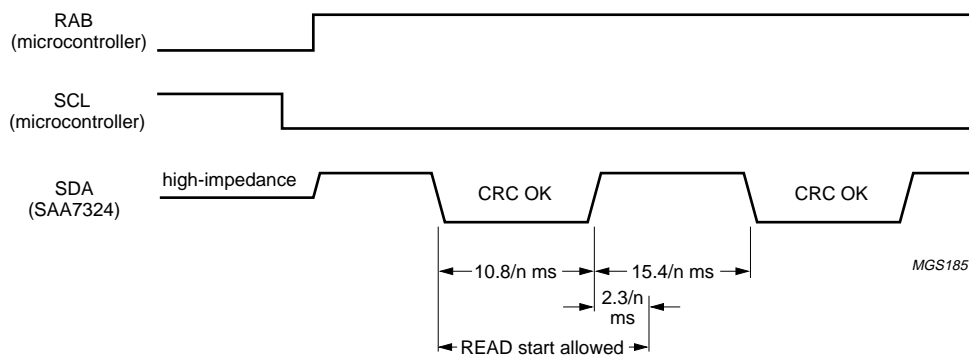
Fig.27 SUBQREADY-I status timing when no subcode is read.
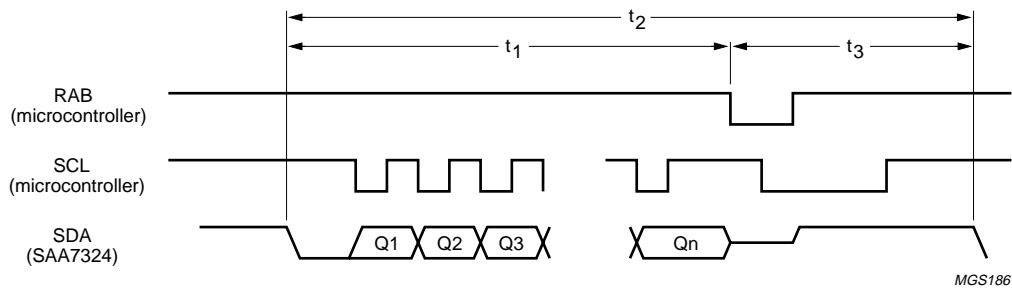
Fig.28 SUBQREADY-I status timing when subcode is read.
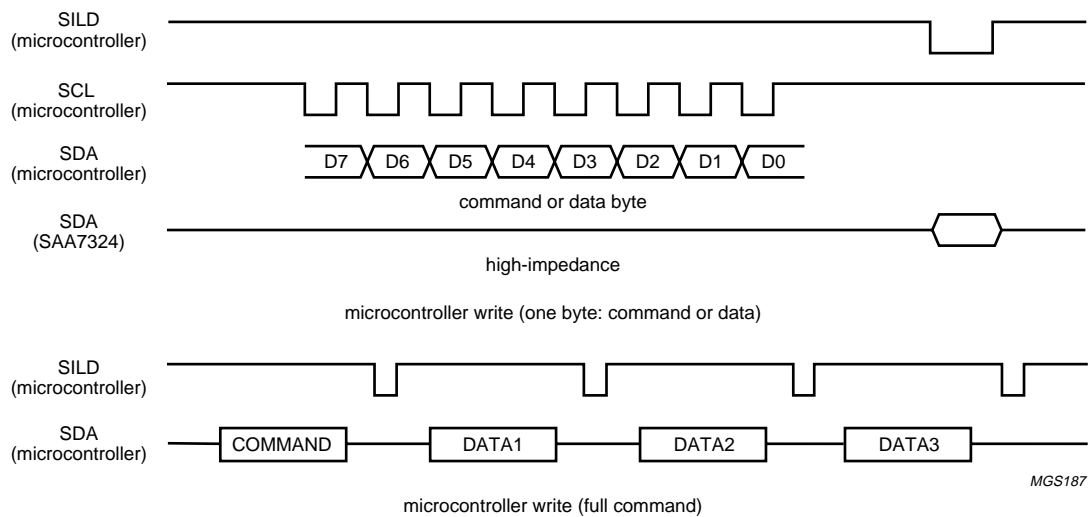
Fig.29 Microcontroller protocol for write servo commands.
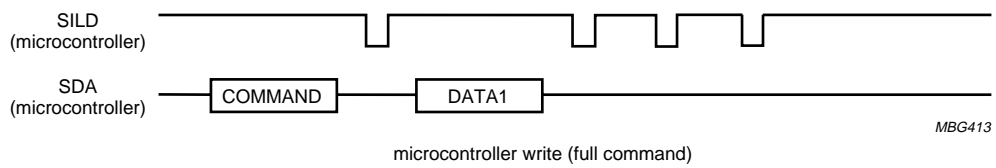
Fig.30 Microcontroller protocol for repeated data in write servo commands.
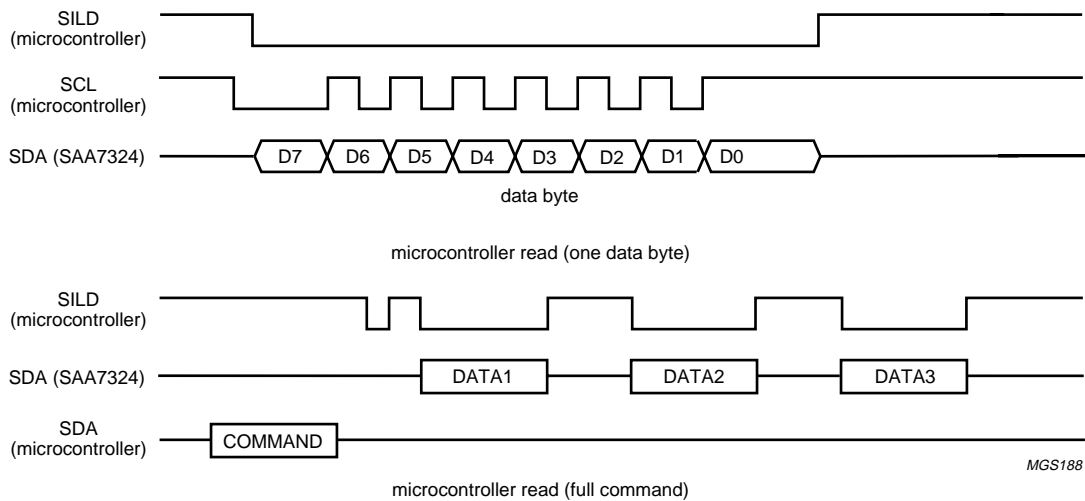
Fig.31 Microcontroller protocol for read servo commands.

7.15.3 DECODER REGISTERS AND SHADOW REGISTERS

To maintain compatibility with the SAA737x series,
decoder registers 0 to F are identical to the SAA7370.
However, to control the extra functionality of SAA7324, a
new set of registers called shadow registers have been
implemented.

These are accessed by using the LSB of decoder
register F. This bit is called SHADEN (shadow registers
enable) on SAA7324. When this bit is set to logic 1
(i.e. decoder register F set to XXX1), any subsequent
addresses will be decoded by the shadow registers.
In fact, only four addresses are implemented as shadow
registers; 3, 7, A and C. Any other addresses sent while
SHADEN = 1 are invalid and have no effect.

When SHADEN is set to logic 0 (decoder register F set to
XXX0) all subsequent addresses are decoded by the main
decoder registers again.

Access to decoder register F is always enabled so that
SHADEN can be set or reset as required.

The SHADEN bit and subsequent shadow registers are
programmed identically to the main decoder registers,
i.e. they can be directly programmed when using the
SAA7324 in 4-wire mode or programmed via the servo
interface when using 3-wire or I^{2}C-bus modes.

The main decoder registers are given in Table 14.
The functions implemented using shadow registers are
given in Table 16.

7.15.4 SUMMARY OF FUNCTIONS CONTROLLED BY DECODER REGISTERS 0 TO F

Table 14 Registers 0 to F

REGISTER	ADDRESS	DATA	FUNCTION	INITIAL[1]
0 (fade and attenuation)	0000	0000	mute	reset
		0010	attenuate	–
		0001	full-scale	–
		0100	step down	–
		0101	step up	–
1 (motor mode)	0001	X000	motor off mode	reset
		X 001	motor stop mode 1	–
		X010	motor stop mode 2	–
		X011	motor start mode 1	–
		X100	motor start mode 2	–
		X101	motor jump mode	–
		X111	motor play mode	–
		X110	motor jump mode 1	–
		1XXX	anti-windup active	–
		0XXX	anti-windup off	reset

REGISTER	ADDRESS	DATA	FUNCTION	INITIAL[1]
2 (status control to servo part - not the STATUS pin)	0010	0000	status = SUBQREADY-I	reset
		0001	status = MOTSTART1	–
		0010	status = MOTSTART2	–
		0011	status = MOTSTOP	–
		0100	status = PLL lock	–
		0101	status = V1	–
		0110	status = V2	–
		0111	status = MOTOR-OV	–
		1000	status = FIFO overflow	–
		1001	status = shock detect	–
		1010	status = latched shock detect	–
		1011	status = latched shock detect reset	–
3 (DAC output)	0011	1010	I^2S-bus; CD-ROM mode	–
		1011	EIAJ; CD-ROM mode	–
		1100	I^2S-bus; 18-bit; $4f_s$ mode	reset
		1111	I^2S-bus; 18-bit; $2f_s$ mode	–
		1110	I^2S-bus; 16-bit; f_s mode	–
		0000	EIAJ; 16-bit; $4f_s$	–
		0011	EIAJ; 16-bit; $2f_s$	–
		0010	EIAJ; 16-bit; f_s	–
		0100	EIAJ; 18-bit; $4f_s$	–
		0111	EIAJ; 18-bit; $2f_s$	–
		0110	EIAJ; 18-bit; f_s	–
4 (motor gain)	0100	X000	motor gain G = 3.2	reset
		X001	motor gain G = 4.0	–
		X010	motor gain G = 6.4	–
		X011	motor gain G = 8.0	–
		X100	motor gain G = 12.8	–
		X101	motor gain G = 16.0	–
		X110	motor gain G = 25.6	–
		X111	motor gain G = 32.0	–
		0XXX	disable comparator clock divider	reset
		1XXX	enable comparator clock divider; only if SELLPLL set HIGH	–
5 (motor bandwidth)	0101	XX00	motor $f_4 = 0.5 \times n$ Hz	reset
		XX01	motor $f_4 = 0.7 \times n$ Hz	–
		XX10	motor $f_4 = 1.4 \times n$ Hz	–
		XX11	motor $f_4 = 2.8 \times n$ Hz	–
		00XX	motor $f_3 = 0.85 \times n$ Hz	reset
		01XX	motor $f_3 = 1.71 \times n$ Hz	–
		10XX	motor $f_3 = 3.42 \times n$ Hz	–

REGISTER	ADDRESS	DATA	FUNCTION	INITIAL[1]
6 (motor output configuration)	0110	XX00	motor power maximum 37%	reset
		XX01	motor power maximum 50%	–
		XX10	motor power maximum 75%	–
		XX11	motor power maximum 100%	–
		00XX	MOTO1, MOTO2 pins 3-state	reset
		01XX	motor PWM mode	–
		10XX	motor PDM mode	–
		11XX	motor CDV mode	–
7 (DAC output and status control)	0111	XX00	interrupt signal from servo at STATUS pin	reset
		XX10	status bit from decoder status register at STATUS pin	–
		X0XX	DAC data normal value	reset
		X1XX	DAC data inverted value	–
		0XXX	left channel first at DAC (WCLK normal)	reset
		1XXX	right channel first at DAC (WCLK inverted)	–
8 (PLL loop filter bandwidth)			see Table 15	–
9 (PLL equalization)	1001	0011	PLL loop filter equalization	reset
		0001	PLL 30 ns over-equalization	–
		0010	PLL 15 ns over-equalization	–
		0100	PLL 15 ns under-equalization	–
		0101	PLL 30 ns under-equalization	–
A (EBU output)	1010	XX0X	EBU data before concealment	–
		XX1X	EBU data after concealment and fade	reset
		X0X0	level II clock accuracy (<1000 ppm)	reset
		X0X1	level I clock accuracy (<50 ppm)	–
		X1X0	level III clock accuracy (>1000 ppm)	–
		X1X1	EBU off - output low	–
		0XXX	flags in EBU off	reset
		1XXX	flags in EBU on	–
B (speed control)	1011	X0XX	33.8688 MHz crystal present, or 8.4672 MHz (or 16.9344 MHz) crystal with SELPLL set HIGH	reset
		X1XX	16.9344 MHz crystal present	–
		0XXX	single-speed mode	reset
		1XXX	double-speed mode	–
		XX00	standby 1: 'CD-STOP' mode	reset
		XX10	standby 2: 'CD-PAUSE' mode	–
		XX11	operating mode	–

Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

SAA7324

REGISTER	ADDRESS	DATA	FUNCTION	INITIAL[1]
C (versatile pins interface)	1100	XXX1	external off-track signal input at V1	–
		XXX0	internal off-track signal used (V1 may be read via status)	reset
		XX0X	kill-L at KILL output, kill-R at V3 output	–
		001X	V3 = 0; single KILL output	reset
		011X	V3 = 1; single KILL output	–
D (versatile pins interface)	1101	0000	4-line motor (using V4 and V5)	–
		XX01	Q-to-W subcode at V4	–
		XX10	V4 = 0	–
		XX11	V4 = 1	reset
		01XX	de-emphasis signal at V5, no internal de-emphasis filter	–
		10XX	V5 = 0	–
		11XX	V5 = 1	reset
E	1110	00XX	audio features disabled	–
		01XX	audio features enabled	reset
		XX0X	lock-to-disc mode disabled	reset
		XX1X	lock-to-disc mode enabled	–
		XXX0	motor brakes to 12%	reset
		XXX1	motor brakes to 6%	–
F (subcode interface and shadow register enable)	1111	X0XX	subcode interface off	reset
		X1XX	subcode interface on	–
		0XXX	4-wire subcode	reset
		1XXX	3-wire subcode	–
		XXX0	SHADEN = 0; shadow registers not enabled; addresses will be decoded by main decoder registers	reset
		XXX1	SHADEN = 1; shadow registers enabled; all subsequent addresses will be decoded by shadow registers, not decoder registers	–

Note

1. The initial column shows the Power-on reset state.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)   SAA7324

Table 15 Loop filter bandwidth

REGISTER	ADDRESS	DATA	FUNCTION			INITIAL[1]
			LOOP BANDWIDTH (HZ)	INTERNAL BANDWIDTH (HZ)	LOW-PASS BANDWIDTH (HZ)	
8 (PLL loop filter bandwidth)	1000	0000	$1640 \times n$	$525 \times n$	$8400 \times n$	–
		0001	$3279 \times n$	$263 \times n$	$16800 \times n$	–
		0010	$6560 \times n$	$131 \times n$	$33600 \times n$	–
		0100	$1640 \times n$	$1050 \times n$	$8400 \times n$	–
		0101	$3279 \times n$	$525 \times n$	$16800 \times n$	–
		0110	$6560 \times n$	$263 \times n$	$33600 \times n$	–
		1000	$1640 \times n$	$2101 \times n$	$8400 \times n$	–
		1001	$3279 \times n$	$1050 \times n$	$16800 \times n$	reset
		1010	$6560 \times n$	$525 \times n$	$33600 \times n$	–
		1100	$1640 \times n$	$4200 \times n$	$8400 \times n$	–
		1101	$3279 \times n$	$2101 \times n$	$16800 \times n$	–
		1110	$6560 \times n$	$1050 \times n$	$33600 \times n$	–

Note

1. The initial column shows the Power-on reset state.

7.15.5   SUMMARY OF FUNCTIONS CONTROLLED BY SHADOW REGISTERS

Table 16 Shadow register settings

SHADEN BIT	SHADOW REGISTER	ADDRESS	DATA	FUNCTION	INITIAL
1	3 control of versatile and clock pins	0011	XXX0	select CL4 on CL11/4 output	reset
			XXX1	select CL11 on CL11/4 output	–
			XX0X	enable CL11/4 output pin	reset
			XX1X	set CL11/4 output pin to high-impedance	–
			X0XX	enable CL16 output pin	reset
			X1XX	set CL16 output pin to high-impedance	–
			0XXX	V2/V3 pin configured as V2 input	reset
			1XXX	V2/V3 pin configured as V3 output (open-drain)	–

SHADEN BIT	SHADOW REGISTER	ADDRESS	DATA	FUNCTION	INITIAL
1	7 control of onboard DAC	0111	XXX0	hold onboard DAC outputs at zero	reset
			XXX1	enable onboard DAC outputs	–
			XX0X	use external DAC or route audio data into onboard DAC (loopback mode)	reset
			XX1X	route audio data into onboard DAC (non-loopback mode)	–
	7 servo reference pin = 7, V_{RIN}		X1XX	use internal reference for servo reference voltage	reset
			X0XX	use external reference for servo reference voltage	–
	A signal magnitude control for diodes D1 to D4	1010	0000	$(0.042).I_{ref} = 1.006 \ \mu A$ (nominal)	–
			0001	$(0.083).I_{ref} = 2.013 \ \mu A$ (nominal)	–
			0010	$(0.125).I_{ref} = 3.019 \ \mu A$ (nominal)	–
			0011	$(0.167).I_{ref} = 4.025 \ \mu A$ (nominal)	–
			0100	$(0.208).I_{ref} = 5.031 \ \mu A$ (nominal)	–
			0101	$(0.25).I_{ref} = 6.034 \ \mu A$ (nominal)	–
			0110	$(0.292).I_{ref} = 7.044 \ \mu A$ (nominal)	–
			0111	$(0.333).I_{ref} = 8.05 \ \mu A$ (nominal)	–
			1000	$(0.375).I_{ref} = 9.056 \ \mu A$ (nominal)	–
			1001	$(0.417).I_{ref} = 10.063 \ \mu A$ (nominal)	–
			1010	$(0.458).I_{ref} = 11.069 \ \mu A$ (nominal)	–
			1011	$(0.5).I_{ref} = 12.075 \ \mu A$ (nominal)	–
			1100	$(0.542).I_{ref} = 13.081 \ \mu A$ (nominal)	–
			1101	$(0.583).I_{ref} = 14.088 \ \mu A$ (nominal)	–
			1110	$(0.625).I_{ref} = 15.094 \ \mu A$ (nominal)	–
			1111	$(0.667).I_{ref} = 16.1 \ \mu A$ (nominal)	reset

SHADEN BIT	SHADOW REGISTER	ADDRESS	DATA	FUNCTION	INITIAL
1	C signal magnitude control for diodes R1 and R2	1100	0000	$(0.042).I_{ref} = 1.006$ μA (nominal)	–
			0001	$(0.083).I_{ref} = 2.013$ μA (nominal)	–
			0010	$(0.125).I_{ref} = 3.019$ μA (nominal)	–
			0011	$(0.167).I_{ref} = 4.025$ μA (nominal)	–
			0100	$(0.208).I_{ref} = 5.031$ μA (nominal)	–
			0101	$(0.25).I_{ref} = 6.034$ μA (nominal)	–
			0110	$(0.292).I_{ref} = 7.044$ μA (nominal)	–
			0111	$(0.333).I_{ref} = 8.05$ μA (nominal)	–
			1000	$(0.375).I_{ref} = 9.056$ μA (nominal)	–
			1001	$(0.417).I_{ref} = 10.063$ μA (nominal)	–
			1010	$(0.458).I_{ref} = 11.069$ μA (nominal)	–
			1011	$(0.5).I_{ref} = 12.075$ μA (nominal)	–
			1100	$(0.542).I_{ref} = 13.081$ μA (nominal)	–
			1101	$(0.583).I_{ref} = 14.088$ μA (nominal)	–
			1110	$(0.625).I_{ref} = 15.094$ μA (nominal)	–
			1111	$(0.667).I_{ref} = 16.1$ μA (nominal)	reset

7.15.6 SUMMARY OF SERVO COMMANDS

A list of the servo commands are given in Table 17. These are fully compatible with the SAA7370.

Table 17 SAA7324 servo commands

COMMANDS	CODE	BYTES	PARAMETERS
Write commands			
Write_focus_coefs1	17H	7	<foc_parm3> <foc_int> <ramp_incr> <ramp_height> <ramp_offset> <FE_start> <foc_gain>
Write_focus_coefs2	27H	7	<defect_parm> <rad_parm_jump> <vel_parm2> <vel_parm1> <foc_parm1> <foc_parm2> <CA_drop>
Write_focus_command	33H	3	<foc_mask> <foc_stat> <shock_level>
Focus_gain_up	42H	2	<foc_gain> <foc_parm1>
Focus_gain_down	62H	2	<foc_gain> <foc_parm1>
Write_radial coefs	57H	7	<rad_length_lead> <rad_int> <rad_parm_play> <rad_pole_noise> <rad_gain> <sledge_parm2> <sledge_parm_1>
Preset_Latch	81H	1	<chip_init>
Radial_off	C1H	1	'1CH'
Radial_init	C1H	1	'3CH'
Short_jump	C3H	3	<tracks_hi> <tracks_lo> <rad_stat>
Long_jump	C5H	5	<brake_dist> <sledge_U_max> <tracks_hi> <tracks_lo> <rad_stat>
Steer_sledge	B1H	1	<sledge_level>
Preset_init	93H	3	<re_offset> <re_gain> <sum_gain>
Write_decoder_reg[1]	D1H	1	<decoder_reg_data>
Write_parameter	A2H	2	<param_ram_addr> <param_data>
Read commands			
Read_Q_subcode[1][2]	0H	up to 12	<Q_sub1 to 10> <peak_l> <peak_r>
Read_status	70H	up to 5	<foc_stat> <rad_stat> <rad_int_lpf> <tracks_hi> <tracks_lo>
Read_hilevel_status[3]	E0H	up to 4	<intreq> <dec_stat> <seq_stat> <motor_start_time>
Read_aux_status	F0H	up to 3	<re_offset> <re_gain> <sum_gain>

Notes

1. These commands only available when internal decoder interface is enabled.

2. <peak_l> and <peak_r> bytes are clocked out LSB first.

3. Decoder status flag information in <dec_stat> is only valid when the internal decoder interface is enabled.

7.15.7 SUMMARY OF SERVO COMMAND PARAMETERS

Table 18 Servo command parameters

PARAMETER	RAM ADDRESS	AFFECTS	POR VALUE	DETERMINES
foc_parm_1	–	focus PID	–	end of focus lead
				defect detector enabling
foc_parm_2	–	focus PID	–	focus low-pass
				focus error normalising
foc_parm_3	–	focus PID	–	focus lead length
				minimum light level
foc_int	14H	focus PID	–	focus integrator crossover frequency
foc_gain	15H	focus PID	70H	focus PID loop gain
CA_drop	12H	focus PID	–	sensitivity of dropout detector
ramp_offset	16H	focus ramp	–	asymmetry of focus ramp
ramp_height	18H	focus ramp	–	peak-to-peak value of ramp voltage
ramp_incr	–	focus ramp	–	slope of ramp voltage
FE_start	19H	focus ramp	–	minimum value of focus error
rad_parm_play	28H	radial PID	–	end of radial lead
rad_pole_noise	29H	radial PID	–	radial low-pass
rad_length_lead	1CH	radial PID	–	length of radial lead
rad_int	1EH	radial PID	–	radial integrator crossover frequency
rad_gain	2AH	radial PID	70H	radial loop gain
rad_parm_jump	27H	radial jump	–	filter during jump
vel_parm1	1FH	radial jump	–	PI controller crossover frequencies
vel_parm2	32H	radial jump	–	jump pre-defined profile
speed_threshold	48H	radial jump	–	maximum speed in fastrad mode
hold_mult	49H	radial jump	00H	electronic damping
				sledge bandwidth during jump
brake_dist_max	21H	radial jump	–	maximum sledge distance allowed in fast actuator steered mode
sledge_long_brake	58H	radial jump	FFH	brake distance of sledge
sledge_Umax	–	sledge	–	voltage on sledge during long jump
sledge_level	–	sledge	–	voltage on sledge when steered
sledge_parm_1	36H	sledge	–	sledge integrator crossover frequency
sledge_parm_2	17H	sledge	–	sledge low-pass frequencies
				sledge gain
				sledge operation mode
sledge_pulse1	46H	pulsed sledge	–	pulse width
sledge_pulse2	64H	pulsed sledge	–	pulse height
defect_parm	–	defect detector	–	defect detector setting
shock_level	–	shock detector	–	shock detector operation
playwatchtime	54H	Watchdog	–	radial on-track Watchdog time

PARAMETER	RAM ADDRESS	AFFECTS	POR VALUE	DETERMINES
jumpwatchtime	57H	Watchdog	–	radial jump Watchdog time-out
radcontrol	59H	Watchdog	–	enable/disable automatic radial off feature
chip_init	–	set-up	–	enable/disable decoder interface
xtra_preset	4AH	set-up	38H	laser on/off
				RA, FO and SL PDM modulating frequency
				fast jumping circuit on/off
cd6cmd	4DH	decoder interface	–	decoder part commands
interrupt_mask	53H	STATUS pin	–	enabled interrupts
seq_control	42H	autosequencer	–	autosequencer control
focus_start_time	5EH	autosequencer	–	focus start time
motor_start_time1	5FH	autosequencer	–	motor start 1 time
motor_start_time2	60H	autosequencer	–	motor start 2 time
radial_init_time	61H	autosequencer	–	radial initialization time
brake_time	62H	autosequencer	–	brake time
RadCmdByte	63H	autosequencer	–	radial command byte
osc_inc	68H	focus/radial AGC	–	AGC control
			–	frequency of injected signal
phase_shift	67H	focus/radial AGC	–	phase shift of injected signal
level1	69H	focus/radial AGC	–	amplitude of signal injected
level2	6AH	focus/radial AGC	–	amplitude of signal injected
agc_gain	6CH	focus/radial AGC	–	focus/radial gain

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

8 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DD}	supply voltage	note 1	−0.5	+3.6	V
$V_{I(max)}$	maximum input voltage				
	any input		−0.5	V_{DD} + 0.5	V
	pins RESET, SDA, SCL, RAB and SILD		−0.5	+5.5	V
V_O	output voltage (any output)		−0.5	+3.6	V
$V_{DD(diff)}$	difference between V_{DDA}, V_{DDD} and V_{pos}		–	±0.25	V
I_O	output current (continuous)		–	±20	mA
$I_{I(d)}$	DC input diode current (continuous)		–	±20	mA
V_{es}	electrostatic handling	note 2	−2000	+2000	V
		note 3	−200	+200	V
T_{amb}	ambient temperature		−10	+70	°C
T_{stg}	storage temperature		−55	+125	°C

Notes

1. All V_{DD} (and V_{pos}) connections and V_{SS} (and V_{neg}) connections must be made externally to the same power supply.

2. Equivalent to discharging a 100 pF capacitor via a 1.5 kΩ series resistor with a rise time of 15 ns.

3. Equivalent to discharging a 200 pF capacitor via a 2.5 µH series inductor.

9 CHARACTERISTICS

V_{DD} = 3.0 to 3.6 V; V_{SS} = 0 V; T_{amb} = −10 to +70 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply						
V_{DD}	supply voltage		3.0	3.3	3.6	V
I_{DD}	supply current	V_{DD} = 3.3 V; n = 1 mode	–	20	–	mA
		V_{DD} = 3.3 V; n = 2 mode	–	25	–	mA
		V_{DD} = 3.3 V; n = 4 mode	–	30	–	mA
Bitstream DAC output (V_{DDD} = 3.3 V, V_{pos} = 3.3 V; V_{SS} = 0 V, V_{neg} = 0 V; T_{amb} = 25 °C)						
DIFFERENTIAL OUTPUTS: PINS LN, LP, RN AND RP						
S/N	signal-to-noise ratio	note 1	−85	−90	–	dB
(THD + N)/S	total harmonic distortion plus noise-to-signal ratio	at 0 dB; note 1	–	−83	−80	dB
Servo and decoder analog functions (V_{DDA} = 3.3 V; V_{SSA} = 0 V; T_{amb} = 25 °C)						
REFERENCE GENERATOR: PIN I_{REF}						
V_{Iref}	reference voltage level		1.14	1.2	1.26	V
I_{ref}	input reference current		–	40	–	µA
R_{Iref}	external resistor	±2%	–	30	–	kΩ

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Decoder analog front-end (V_{DDA} = 3.3 V; V_{SSA} = 0 V; T_{amb} = 25 °C)						
COMPARATOR INPUTS: PINS HFIN AND HFREF						
f_{clk}	clock frequency	note 2	8	–	70	MHz
$V_{th(sw)}$	switching voltage threshold		–	$0.5V_{DD}$	–	V
$V_{i(HFIN)}$	input voltage level pin HFIN		–	1.0	–	V
Servo analog part (V_{DDA} = 3.3 V; V_{SSA} = 0 V; T_{amb} = 25 °C; R_{Iref} = 30 kΩ)						
PINS D1 TO D4; R1 AND R2						
$I_{D(max)}$	maximum input current for central diode input signal	note 3	1.006	–	16.1	μA
$I_{R(max)}$	maximum input current for satellite diode input signal	note 3	1.006	–	16.1	μA
V_{RIN}	internally generated reference voltage	note 4	–	0.75	–	V
	externally generated reference voltage applied to V_{RIN}	note 4	0.5	–	$0.5V_{DD}$ + 0.1	V
(THD + N)/S	total harmonic distortion plus noise-to-signal ratio	at 0 dB; note 5	–	–50	–45	dB
S/N	signal-to-noise ratio		–	55	–	dB
PSRR	power supply ripple rejection at V_{DDA2}	note 6	–	45	–	dB
G_{tol}	gain tolerance	note 7	–20	0	+20	%
ΔG_v	variation of gain between channels		–	–	2	%
α_{cs}	channel separation		–	60	–	dB
Digital inputs						
PINS $\overline{RESET}$ 5 V TOLERANT (CMOS INPUT WITH PULL-UP RESISTOR AND HYSTERESIS)						
$V_{thr(sw)}$	switching voltage threshold rising		–	–	$0.8V_{DDD}$	V
$V_{thf(sw)}$	switching voltage threshold falling		$0.2V_{DDD}$	–	–	V
V_{hys}	hysteresis voltage		0.4	–	–	V
$R_{i(pu)}$	input pull-up resistance	V_i = 0 V, V_{DDD} = 3.3 V	–	50	–	kΩ
C_i	input capacitance		–	–	10	pF
t_{resL}	reset pulse width (active LOW)	$\overline{RESET}$ only	1	–	–	μs
PIN V1 (CMOS INPUT WITH PULL-UP RESISTOR)						
$V_{thr(sw)}$	switching voltage threshold rising		–	–	$0.8V_{DDD}$	V
$V_{thf(sw)}$	switching voltage threshold falling		$0.2V_{DDD}$	–	–	V

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{hys}	hysteresis voltage		–	$0.3V_{DDD}$	–	V
$R_{i(pu)}$	input pull-up resistor	$V_i = 0$ V; $V_{DDD} = 3.3$ V	–	50	–	kΩ
C_i	input capacitance		–	–	10	pF
PIN SELPLL (CMOS INPUT WITH PULL-UP RESISTOR)						
V_{IL}	LOW-level input voltage		–0.3	–	$0.3V_{DDD}$	V
V_{IH}	HIGH-level input voltage		$0.7V_{DDD}$	–	$V_{DDD} + 0.3$	V
$R_{i(pu)}$	input pull-up resistance	$V_i = 0$ V; $V_{DDD} = 3.3$ V	–	50	–	kΩ
C_i	input capacitance		–	–	10	pF
PINS TEST1, TEST2 AND TEST3 (CMOS INPUTS WITH PULL-DOWN RESISTORS)						
V_{IL}	LOW-level input voltage		–0.3	–	$0.3V_{DDD}$	V
V_{IH}	HIGH-level input voltage		$0.7V_{DDD}$	–	$V_{DDD} + 0.3$	V
$R_{i(pd)}$	input pull-down resistance	$V_i = V_{DDD} = 3.3$ V	–	50	–	kΩ
C_i	input capacitance		–	–	10	pF
PINS RCK, WCLI, SDI AND SCLI (CMOS INPUTS)						
V_{IL}	LOW-level input voltage		–0.3	–	$0.3V_{DDD}$	V
V_{IH}	HIGH-level input voltage		$0.7V_{DDD}$	–	$V_{DDD} + 0.3$	V
I_{LI}	input leakage current	$V_i = 0$ to V_{DDD}	–5	–	+5	μA
C_i	input capacitance		–	–	10	pF
PINS SCL, SILD AND RAB (5 V TOLERANT CMOS INPUTS)						
V_{IL}	LOW-level input voltage		–0.3	–	$0.2V_{DDD}$	V
V_{IH}	HIGH-level input voltage		$0.8V_{DDD}$	–	5.5	V
I_{LI}	input leakage current	$V_i = 0$ to V_{DDD}	–5	–	+5	μA
C_i	input capacitance		–	–	10	pF
Digital outputs						
PINS V4 AND V5						
V_{OL}	LOW-level output voltage	$I_{OL} = 4$ mA	0	–	0.4	V
V_{OH}	HIGH-level output voltage	$I_{OH} = -4$ mA	$V_{DDD} - 0.4$	–	V_{DDD}	V
C_L	load capacitance		–	–	100	pF
$t_{o(r)}$	output rise time	$C_L = 20$ pF; 0.4 to $(V_{DDD} - 0.4)$ V	–	–	10	ns
$t_{o(f)}$	output fall time	$C_L = 20$ pF; $(V_{DDD} - 0.4)$ to 0.4 V	–	–	10	ns
Open-drain outputs						
PINS CFLG, STATUS, KILL AND LDON (OPEN-DRAIN OUTPUT)						
V_{OL}	LOW-level output voltage	$I_{OL} = 1$ mA	0	–	0.4	V
I_{OL}	LOW-level output current		–	–	2	mA
C_L	load capacitance		–	–	50	pF
$t_{o(f)}$	output fall time	$C_L = 50$ pF; $(V_{DDD} - 0.4)$ to 0.4 V	–	–	30	ns

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
3-state outputs						
PINS EF, SCLK, WCLK, DATA, CL16, RA, FO, SL, SBSY, SFSY, SUB AND CL11/4						
V_{OL}	LOW-level output voltage	I_{OL} = 1 mA	0	–	0.4	V
V_{OH}	HIGH-level output voltage	I_{OH} = −1 mA	V_{DDD} − 0.4	–	V_{DDD}	V
C_L	load capacitance		–	–	35	pF
$t_{o(r)}$	output rise time	C_L = 20 pF; 0.4 to (V_{DDD} − 0.4) V	–	–	15	ns
$t_{o(f)}$	output fall time	C_L = 20 pF; (V_{DDD} − 0.4) to 0.4 V	–	–	15	ns
I_{ZO}	output 3-state leakage current	V_i = 0 to V_{DD}	−5	–	+5	μA
(WHEN CL11/4 IS CONFIGURED AS CL11 OUTPUT)						
t_{OH}	output HIGH time (relative to clock period)	V_o = 1.5 V	45	50	55	%
PINS MOTO1, MOTO2 AND DOBM						
V_{OL}	LOW-level output voltage	I_{OL} = 4 mA	0	–	0.4	V
V_{OH}	HIGH-level output voltage	I_{OH} = −4 mA	V_{DDD} − 0.4	–	V_{DD}	V
C_L	load capacitance		–	–	100	pF
$t_{o(r)}$	output rise time	C_L = 20 pF; 0.4 to (V_{DDD} − 0.4) V	–	–	10	ns
$t_{o(f)}$	output fall time	C_L = 20 pF; (V_{DDD} − 0.4) to 0.4 V	–	–	10	ns
I_{ZO}	output 3-state leakage current	V_i = 0 to V_{DDD}	−5	–	+5	μA
Digital input/output						
PIN SDA (5 V TOLERANT CMOS INPUT/OPEN-DRAIN I²C-BUS OUTPUT)						
V_{IL}	LOW-level input voltage		−0.3	–	+0.2V_{DDD}	V
V_{IH}	HIGH-level input voltage		0.8V_{DDD}	–	5.5	V
I_{ZO}	3-state leakage current	V_i = 0 to V_{DDD}	−5	–	+5	μA
C_i	input capacitance		–	–	10	pF
V_{OL}	LOW-level output voltage	I_{OL} = 2 mA	0	–	0.4	V
I_{OL}	LOW-level output current		–	–	6	mA
C_L	load capacitance		–	–	50	pF
$t_{o(f)}$	output fall time	C_L = 20 pF; 0.85V_{DDD} to 0.4 V	–	–	15	ns
PIN V2/V3 (CMOS INPUT WITH PULL-UP RESISTOR AND HYSTERESIS/OPEN-DRAIN OUTPUT)						
$V_{thr(sw)}$	switching voltage threshold rising		–	–	0.8V_{DDD}	V
$V_{thf(sw)}$	switching voltage threshold falling		0.2V_{DDD}	–	–	V
V_{hys}	hysteresis voltage		–	0.3V_{DDD}	–	V

Digital servo processor and Compact Disc decoder with integrated DAC (CD10 II)

SAA7324

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{I(pu)}$	input pull-up resistance	$V_i = 0$ V; $V_{DDD} = 3.3$ V	–	50	–	kΩ
C_i	input capacitance		–	–	10	pF
V_{OL}	LOW-level output voltage	$I_{OL} = 1$ mA	0	–	0.4	V
I_{OL}	LOW-level output current		–	–	1	mA
C_L	load capacitance		–	–	25	pF
$t_{o(f)}$	output fall time	$C_L = 20$ pF; ($V_{DDD} - 0.4$) to 0.4 V	–	–	15	ns
Crystal oscillator						
INPUT: PIN CRIN (EXTERNAL CLOCK)						
V_{IL}	LOW-level input voltage		–0.3	–	$+0.2V_{DD}$	V
V_{IH}	HIGH-level input voltage		$0.8V_{DD}$	–	$V_{DD} + 0.3$	V
I_{LI}	input leakage current		–10	–	+10	μA
C_i	input capacitance		–	–	10	pF
OUTPUT: PIN CROUT; SEE FIGS 3 AND 4						
f_{xtal}	crystal frequency	± 100 ppm	8	8.4672	35	MHz
g_m	mutual conductance at start-up		17	–	–	mA/V
C_{fb}	feedback capacitance		–	–	2	pF
C_o	output capacitance		–	–	7	pF

Notes

1. Assumes use of external components as shown in the application diagram (Figs 38 or 39).

2. Highest clock frequency at which data slicer produces 1010 output in analog self-test mode.

3. The maximum input current depends on the value of the external resistor connected to I_{ref} and the settings of shadow registers A and C:

   a) With $R_{Iref} = 30$ kΩ, minimum $I_{max} = (0.025)$. $I_{ref} \Rightarrow (0.025) \times (40\ \mu A) = 1\ \mu A$.

   b) With $R_{Iref} = 30$ kΩ, maximum $I_{max} = (0.4)$. $I_{ref} \Rightarrow (0.4) \times (40\ \mu A) = 16\ \mu A$.

4. V_{RIN} can be set to an internal source or an externally applied reference voltage using shadow register 7.

5. Measuring bandwidth: 200 Hz to 20 kHz, $f_{i(ADC)} = 1$ kHz.

6. $f_{ripple} = 1$ kHz, $V_{ripple} = 0.5$ V (p-p).

7. Gain of the ADC is defined as $G_{ADC} = f_{sys}/I_{max}$ (counts/μA); thus digital output $= I_i \times G_{ADC}$ where:

   a) Digital output = the number of pulses at the digital output in counts/s and I_i = the DC input current in μA.

   b) The maximum input current depends on R_{Iref} and on shadow registers A and C.

   c) The gain tolerance is the deviation from the calculated gain.

10 OPERATING CHARACTERISTICS (SUBCODE INTERFACE TIMING)

V_{DD} = 3.0 to 3.6 V; V_{SS} = 0 V; T_{amb} = −10 to +70 °C; unless otherwise specified.

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
Subcode interface timing (single speed × n); see Fig.32; note 1					
INPUT: PIN RCK					
t_{CLKH}	input clock HIGH time	2/n	4/n	6/n	µs
t_{CLKL}	input clock LOW time	2/n	4/n	6/n	µs
t_r	input clock rise time	–	–	80/n	ns
t_f	input clock fall time	–	–	80/n	ns
$t_{d(SFSY-RCK)}$	delay time SFSY to RCK	10/n	–	20/n	µs
OUTPUTS: PINS SBSY, SFSY AND SUB (C_L = 20 PF)					
$T_{cy(block)}$	block cycle time	12.0/n	13.3/n	14.7/n	ms
$t_{W(SBSY)}$	SBSY pulse width	–	–	300/n	µs
$T_{cy(frame)}$	frame cycle time	122/n	136/n	150/n	µs
$t_{W(SFSY)}$	SFSY pulse width (3-wire mode only)	–	–	366/n	µs
t_{SFSYH}	SFSY HIGH time	–	–	66/n	µs
t_{SFSYL}	SFSY LOW time	–	–	84/n	µs
$t_{d(SFSY-SUB)}$	delay time SFSY to SUB (P data) valid	–	–	1/n	µs
$t_{d(RCK-SUB)}$	delay time RCK falling to SUB	–	–	0	µs
$t_{h(RCK-SUB)}$	hold time RCK to SUB	–	–	0.7/n	µs

Note

1. The subcode timing is directly related to the overspeed factor 'n' in normal operating mode. 'n' is replaced by the disc speed factor 'd', in lock-to-disc mode.

Digital servo processor and Compact Disc
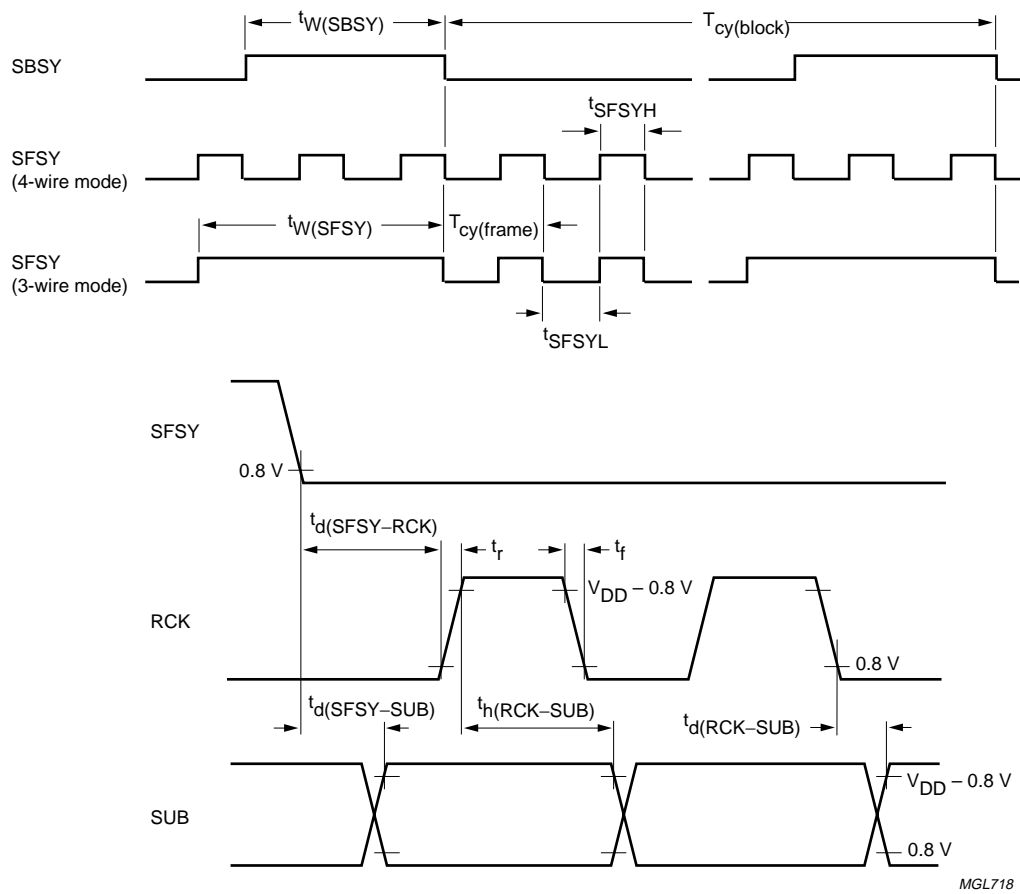decoder with integrated DAC (CD10 II)

SAA7324

Fig.32 Subcode interface timing diagram.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

11 OPERATING CHARACTERISTICS (I²S-BUS TIMING)

V_{DD} = 3.0 to 3.6 V; V_{SS} = 0 V; T_{amb} = −10 to +70 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I²S-bus timing (single-speed × n); see Fig.33**; note** 1						
CLOCK OUTPUT: PIN SCLK (C_L = 20 PF)						
T_{cy}	output clock period	sample rate = f_s	–	472.4/n	–	ns
		sample rate = $2f_s$	–	236.2/n	–	ns
		sample rate = $4f_s$	–	118.1/n	–	ns
t_{CH}	clock HIGH time	sample rate = f_s	166/n	–	–	ns
		sample rate = $2f_s$	83/n	–	–	ns
		sample rate = $4f_s$	42/n	–	–	ns
t_{CL}	clock LOW time	sample rate = f_s	166/n	–	–	ns
		sample rate = $2f_s$	83/n	–	–	ns
		sample rate = $4f_s$	42/n	–	–	ns
OUTPUTS: PINS WCLK, DATA AND EF (C_L = 20 PF)						
t_{su}	set-up time	sample rate = f_s	95/n	–	–	ns
		sample rate = $2f_s$	48/n	–	–	ns
		sample rate = $4f_s$	24/n	–	–	ns
t_h	hold time	sample rate = f_s	95/n	–	–	ns
		sample rate = $2f_s$	48/n	–	–	ns
		sample rate = $4f_s$	24/n	–	–	ns

Note

1. The I²S-bus timing is directly related to the overspeed factor 'n' in the normal operating mode. In the lock-to-disc mode 'n' is replaced by the disc speed factor 'd'.
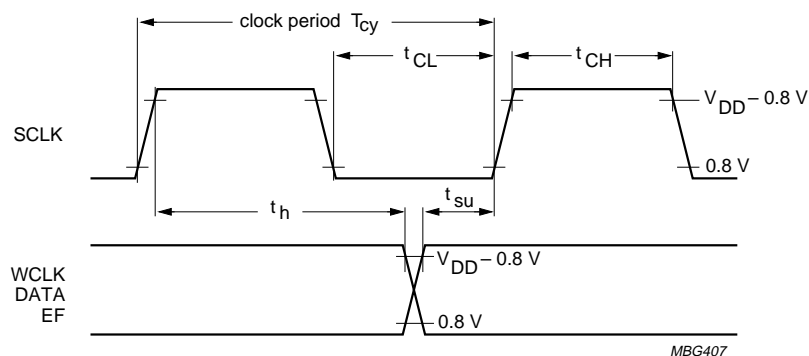

Fig.33 I²S-bus timing diagram.

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

12 OPERATING CHARACTERISTICS (MICROCONTROLLER INTERFACE TIMING)

V_{DD} = 3.0 to 3.6 V; V_{SS} = 0 V; T_{amb} = −10 to +70 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	NORMAL MODE		LOCK-TO-DISC MODE		UNIT
			MIN.	MAX.	MIN.	MAX.	
Microcontroller interface timing (4-wire bus mode; writing to decoder registers 0 to F; reading Q-channel subcode and decoder status); see Figs 34 and 35; note 1							
INPUTS SCL AND RAB							
t_{CL}	input LOW time		480/n + 20	–	2400/n + 20	–	ns
t_{CH}	input HIGH time		480/n + 20	–	2400/n + 20	–	ns
t_r	rise time		–	480/n	–	480/n	ns
t_f	fall time		–	480/n	–	480/n	ns
READ MODE (C_L = 20 PF)							
t_{dRD}	delay time RAB to SDA valid		–	50	–	50	ns
t_{PD}	propagation delay SCL to SDA		720/n − 20	960/n + 20	720/n + 20	4800/n + 20	ns
t_{dRZ}	delay time RAB to SDA high-impedance		–	50	–	50	ns
WRITE MODE (C_L = 20 PF)							
t_{suD}	set-up time SDA to SCL	note 2	20 − 720/n	–	20 − 720/n	–	ns
t_{hD}	hold time SCL to SDA		–	960/n + 20	–	4800/n + 20	ns
t_{suCR}	set-up time SCL to RAB		240/n + 20	–	1200/n + 20	–	ns
t_{dWZ}	delay time SDA high-impedance to RAB		0	–	0	–	ns
Microcontroller interface timing (4-wire bus mode; servo commands); see Figs 36 and 37; note 3							
INPUTS SCL AND SILD							
t_L	input LOW time		710	–	710	–	ns
t_H	input HIGH time		710	–	710	–	ns
t_r	rise time		–	240	–	240	ns
t_f	fall time		–	240	–	240	ns
READ MODE (C_L = 20 PF)							
t_{dLD}	delay time SILD to SDA valid		–	25	–	25	ns
t_{PD}	propagation delay SCL to SDA		–	950	–	950	ns
t_{dLZ}	delay time SILD to SDA high-impedance		–	50	–	50	ns
t_{sCLR}	set-up time SCL to SILD		480	–	480	–	ns
t_{hCLR}	hold time SILD to SCL		830	–	830	–	ns

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

SYMBOL	PARAMETER	CONDITIONS	NORMAL MODE		LOCK-TO-DISC MODE		UNIT
			MIN.	MAX.	MIN.	MAX.	
WRITE MODE (C_L = 20 PF)							
t_{sD}	set-up time SDA to SCL		0	–	0	–	ns
t_{hD}	hold time SCL to SDA		950	–	950	–	ns
t_{sCL}	set-up time SCL to SILD		480	–	480	–	ns
t_{hCL}	hold time SILD to SCL		120	–	120	–	ns
t_{dPLP}	delay between two SILD pulses		70	–	70	–	µs
t_{dWZ}	delay time SDA high-impedance to SILD		0	–	0	–	ns

Notes

1. The 4-wire bus mode microcontroller interface timing for writing to decoder registers 0 to F, and reading Q-channel subcode and decoder status, is a function of the overspeed factor 'n'. In the lock-to-disc mode the maximum data rate is lower.

2. Negative set-up time means that the data may change after clock transition.

3. If a 16.9344 MHz crystal is used and SELPLL = 0 then the timings are divided-by-2 until the microcontroller has written X1XX to register B.
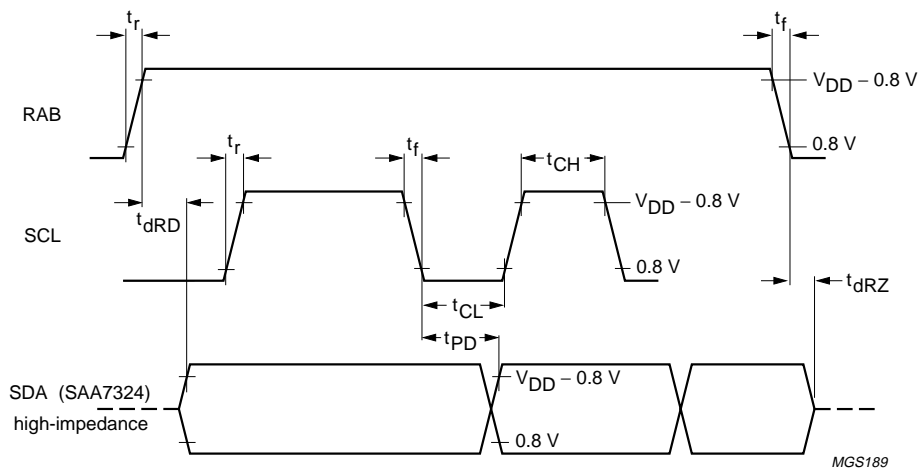
Fig.34 4-wire bus microcontroller timing; read mode (Q-channel subcode and decoder status information).
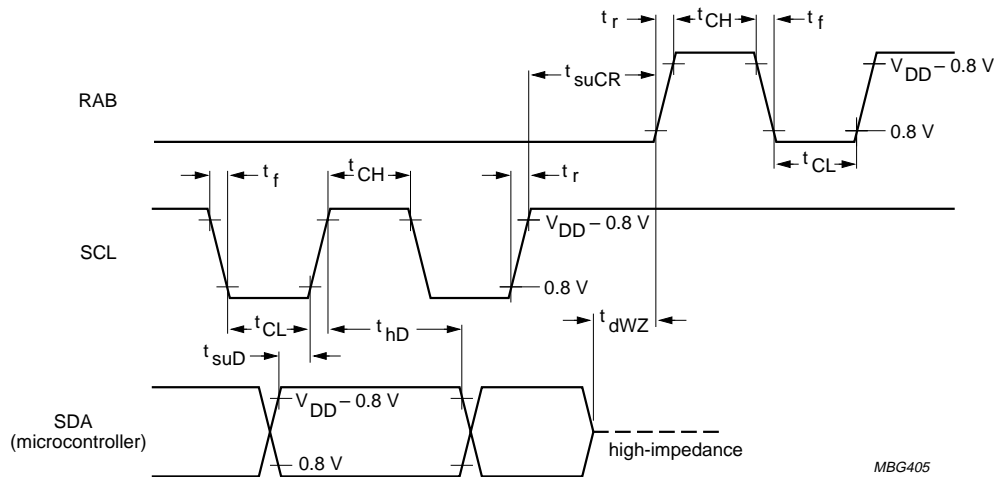
Fig.35 4-wire bus microcontroller timing; write mode (decoder registers 0 to F).
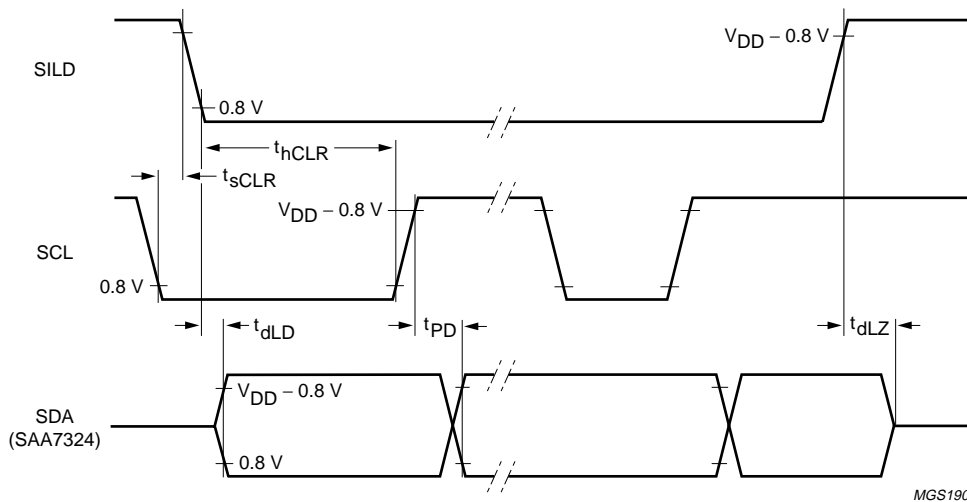
Fig.36 4-wire bus microcontroller timing; read mode (servo commands).
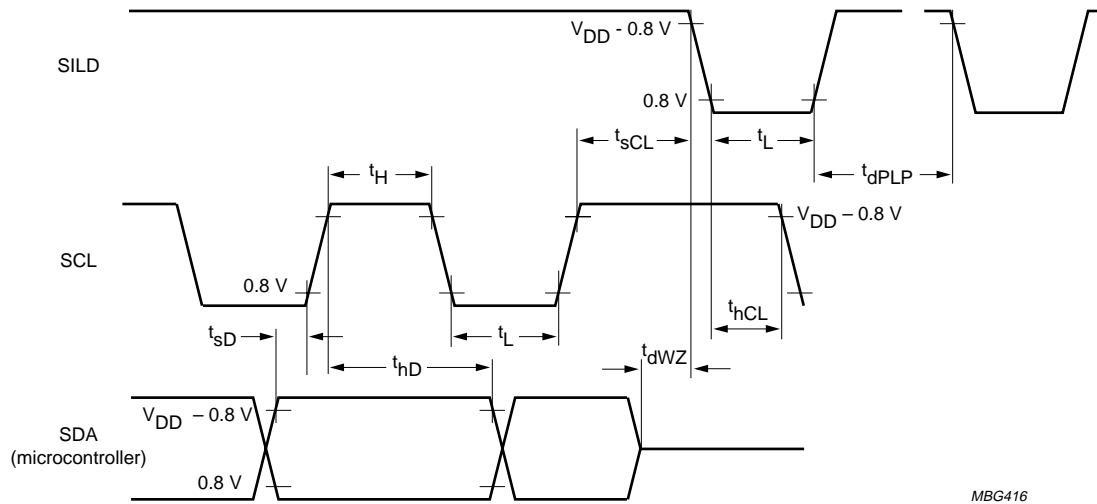
Fig.37 4-wire bus microcontroller timing; write mode (servo commands).

Philips Semiconductors

Product specification

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

2000 Jun 26

61

13 APPLICATION INFORMATION

(1) For crystal oscillator see Figs 3 and 4.

(2) 1.5 nF capacitors connected between pins LN and LP, and RN and RP must be placed as near to the pins as possible. This also applies to the 220 nF and 47 µF capacitors connected between pins V_{neg} and V_{pos}. Power supplies and V_{DDD} reference inputs ($\frac{1}{2}V_{DDD}$) for DAC operational amplifiers must be low noise.

(3) For single speed applications, use 47 pF capacitors, for double speed use 22 pF capacitors.

(4) The connections to TDA1300 are shown for single Foucault mechanisms.

MGS191

Fig.38 Typical application diagram (for current mechanisms).

Philips Semiconductors

Product specification

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

2000 Jun 26

62

(1) For crystal oscillator see Figs 3 and 4.

(2) 1.5 nF capacitors connected between pins
LN and LP, and RN and RP must be placed as
near to the pins as possible. This also applies to
the 220 nF and 47 μF capacitors connected
between pins V_{neg} and V_{pos}. Power supplies and
V_{DDD} reference inputs ($\frac{1}{2}V_{DDD}$) for DAC
operational amplifiers must be low noise.

(3) For single speed applications, use 47 pF
capacitors, for double speed use 22 pF capacitors.

(4) For connections between OEIC and TZA1024,
refer to TZA1024 device specification.

(5) Components for LP filter and V → I conversion
depend on the OEIC and the current range set on
SAA7324.

Fig.39 Typical application diagram (for voltage mechanisms).

Digital servo processor and Compact Disc
decoder with integrated DAC (CD10 II)

SAA7324

14 PACKAGE OUTLINE

QFP64: plastic quad flat package; 64 leads (lead length 1.6 mm); body 14 x 14 x 2.7 mm

SOT393-1
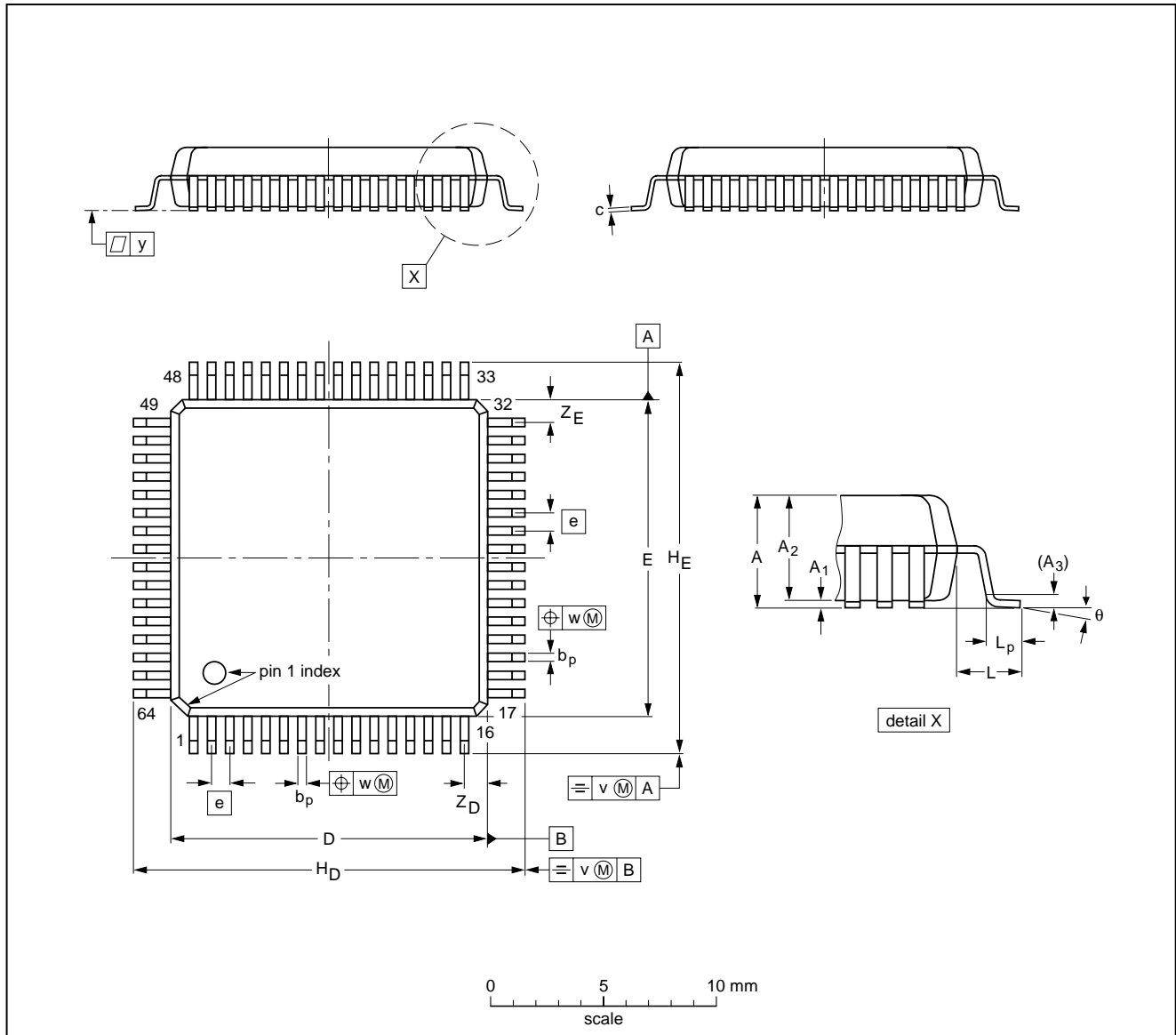
DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D⁽¹⁾	E⁽¹⁾	e	H_D	H_E	L	Lₚ	v	w	y	Z_D⁽¹⁾	Z_E⁽¹⁾	θ
mm	3.00	0.25 0.10	2.75 2.55	0.25	0.45 0.30	0.23 0.13	14.1 13.9	14.1 13.9	0.8	17.45 16.95	17.45 16.95	1.60	1.03 0.73	0.16	0.16	0.10	1.2 0.8	1.2 0.8	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT393-1	134E07	MS-022				~~99-12-27~~ 00-01-19

15 SOLDERING

15.1 Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards with high population densities. In these situations reflow soldering is often used.

15.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferable be kept below 230 °C.

15.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.

- For packages with leads on two sides and a pitch (e):

  – larger than or equal to 1.27 mm, the footprint longitudinal axis is **preferred** to be parallel to the transport direction of the printed-circuit board;

  – smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

  The footprint must incorporate solder thieves at the downstream end.

- For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C.
A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

15.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

15.5   Suitability of surface mount IC packages for wave and reflow soldering methods

PACKAGE	SOLDERING METHOD	
	WAVE	**REFLOW**[1]
BGA, SQFP	not suitable	suitable
HLQFP, HSQFP, HSOP, HTSSOP, SMS	not suitable[2]	suitable
PLCC[3], SO, SOJ	suitable	suitable
LQFP, QFP, TQFP	not recommended[3][4]	suitable
SSOP, TSSOP, VSO	not recommended[5]	suitable

Notes

1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the *"Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods"*.

2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).

3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.

4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.

5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

16 DATA SHEET STATUS

DATA SHEET STATUS	PRODUCT STATUS	DEFINITIONS [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

Note

1. Please consult the most recently issued data sheet before initiating or completing a design.

17 DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

18 DISCLAIMERS

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

19 PURCHASE OF PHILIPS I²C COMPONENTS

Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.

NOTES

Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 3 Figtree Drive, HOMEBUSH, NSW 2140,
Tel. +61 2 9704 8141, Fax. +61 2 9704 8139

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213,
Tel. +43 1 60 101 1248, Fax. +43 1 60 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 20 0733, Fax. +375 172 20 0773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 68 9211, Fax. +359 2 68 9102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381, Fax. +1 800 943 0087

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Sydhavnsgade 23, 1780 COPENHAGEN V,
Tel. +45 33 29 3333, Fax. +45 33 29 3905

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615 800, Fax. +358 9 6158 0920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 4099 6161, Fax. +33 1 4099 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 2353 60, Fax. +49 40 2353 6300

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: PT Philips Development Corporation, Semiconductors Division,
Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510,
Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Via Casati, 23 - 20052 MONZA (MI),
Tel. +39 039 203 6838, Fax +39 039 203 6800

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku,
TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5057

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381, Fax +9-5 800 943 0087

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Pakistan: see Singapore

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Al.Jerozolimskie 195 B, 02-222 WARSAW,
Tel. +48 22 5710 000, Fax. +48 22 5710 001

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 319762,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 58088 Newville 2114,
Tel. +27 11 471 5401, Fax. +27 11 471 5398

South America: Al. Vicente Pinzon, 173, 6th floor,
04547-130 SÃO PAULO, SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 93 301 6312, Fax. +34 93 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 5985 2000, Fax. +46 8 5985 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2741 Fax. +41 1 488 3263

Taiwan: Philips Semiconductors, 5F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2451, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
60/14 MOO 11, Bangna Trad Road KM. 3, Bagna, BANGKOK 10260,
Tel. +66 2 361 7910, Fax. +66 2 398 3447

Turkey: Yukari Dudullu, Org. San. Blg., 2.Cad. Nr. 28 81260 Umraniye,
ISTANBUL, Tel. +90 216 522 1500, Fax. +90 216 522 1813

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 208 730 5000, Fax. +44 208 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381, Fax. +1 800 943 0087

Uruguay: see South America

Vietnam: see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,
Tel. +381 11 3341 299, Fax.+381 11 3342 553

For all other countries apply to: Philips Semiconductors,
Marketing Communications, Building BE-p, P.O. Box 218, 5600 MD EINDHOVEN,
The Netherlands, Fax. +31 40 27 24825

Internet: http://www.semiconductors.philips.com

Let's make things better.

**Philips
Semiconductors**

PHILIPS